



# LP3869x/-Q1 500mA 低压降 CMOS 线性稳压器

## 使用陶瓷输出电容器时可保持稳定

### 1 特性

- 宽输入电压范围 (2.7V 至 10V)
- 所有超薄小外形尺寸无引线封装 (WSON) 选项作为 AEC-Q100 1 级可用
- 2.0% 输出精度 (25°C)
- 低压降: 500mA (5V 输出典型值) 时为 250mV
- 精密 (已调整) 带隙基准
- 可保证 -40°C 至 +125°C 温度范围内的技术规格
- 1μA 关闭状态静态电流
- 热过载保护
- 折返电流限制
- TO-252、SOT-223 和 6 凸点晶圆级小外形无引线 (WSON) 封装
- 使能引脚 (LP38693)

### 2 应用范围

- 硬盘驱动器
- 笔记本电脑
- 电池供电设备
- 便携式仪表

### 3 说明

LP3869x 低压降 CMOS 线性稳压器具有严密的输出容差 (典型值 2%) 和极低压降 (在负载电流为 500mA、V<sub>输出</sub> = 5V 时为 250mV)，并且采用超低等效串联电阻 (ESR) 陶瓷输出电容器，可提供出色的交流性能。

此稳压器采用低热阻的 WSON、SOT-223 以及 TO-252 封装，即使在周围温度较高的环境下也可实现满电流运行。

PMOS 功率晶体管的使用意味着无需直流基极驱动电流对其进行偏置，因此无论负载电流、输入电压或者运行温度为何，接地引脚电流均可保持在 100μA 以下。

压降: 500mA (5V 输出电压典型值) 条件下为 250mV (典型值)

接地引脚电流: 满负载时为 55μA (典型值)

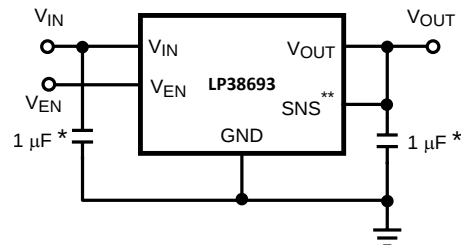
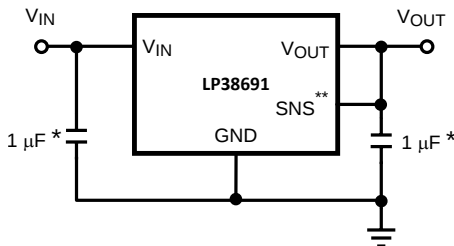
精密输出电压: 精度为 2% (25°C)

器件信息<sup>(1)</sup>

| 器件型号       | 封装          | 封装尺寸 (标称值)      |
|------------|-------------|-----------------|
| LP38691    | TO-252 (3)  | 6.58mm x 6.10mm |
|            | WSON (6)    | 3.00mm x 3.00mm |
| LP38693    | SOT-223 (5) | 6.50mm x 3.56mm |
|            | WSON (6)    | 3.00mm x 3.00mm |
| LP38691-Q1 | WSON (6)    | 3.00mm x 3.00mm |
| LP38693-Q1 |             |                 |

(1) 如需了解所有可用封装，请见数据表末尾的可订购产品附录。

### 4 典型应用电路



\* 稳定状态下的最小值

\*\* 仅限 WSON 封装器件



## 目录

|          |                                              |           |            |                                             |           |
|----------|----------------------------------------------|-----------|------------|---------------------------------------------|-----------|
| <b>1</b> | <b>特性</b> .....                              | <b>1</b>  | <b>8.2</b> | <b>Functional Block Diagrams</b> .....      | <b>11</b> |
| <b>2</b> | <b>应用范围</b> .....                            | <b>1</b>  | <b>8.3</b> | <b>Feature Description</b> .....            | <b>13</b> |
| <b>3</b> | <b>说明</b> .....                              | <b>1</b>  | <b>8.4</b> | <b>Device Functional Modes</b> .....        | <b>13</b> |
| <b>4</b> | <b>典型应用电路</b> .....                          | <b>1</b>  | <b>9</b>   | <b>Application and Implementation</b> ..... | <b>14</b> |
| <b>5</b> | <b>修订历史记录</b> .....                          | <b>2</b>  | <b>9.1</b> | <b>Application Information</b> .....        | <b>14</b> |
| <b>6</b> | <b>Pin Configuration and Functions</b> ..... | <b>3</b>  | <b>9.2</b> | <b>Typical Application</b> .....            | <b>14</b> |
| <b>7</b> | <b>Specifications</b> .....                  | <b>4</b>  | <b>10</b>  | <b>Power Supply Recommendations</b> .....   | <b>19</b> |
| 7.1      | Absolute Maximum Ratings .....               | 4         | <b>11</b>  | <b>Layout</b> .....                         | <b>19</b> |
| 7.2      | Handling Ratings: LP3869x .....              | 4         | 11.1       | Layout Guidelines .....                     | 19        |
| 7.3      | Handling Ratings: LP3869x-Q1 .....           | 4         | 11.2       | Layout Example .....                        | 20        |
| 7.4      | Recommended Operating Conditions .....       | 5         | <b>12</b>  | <b>器件和文档支持</b> .....                        | <b>21</b> |
| 7.5      | Thermal Information .....                    | 5         | 12.1       | 相关链接 .....                                  | 21        |
| 7.6      | Electrical Characteristics .....             | 5         | 12.2       | 商标 .....                                    | 21        |
| 7.7      | Typical Characteristics .....                | 7         | 12.3       | 静电放电警告 .....                                | 21        |
| <b>8</b> | <b>Detailed Description</b> .....            | <b>11</b> | 12.4       | 术语表 .....                                   | 21        |
| 8.1      | Overview .....                               | 11        | <b>13</b>  | <b>机械封装和可订购信息</b> .....                     | <b>21</b> |

## 5 修订历史记录

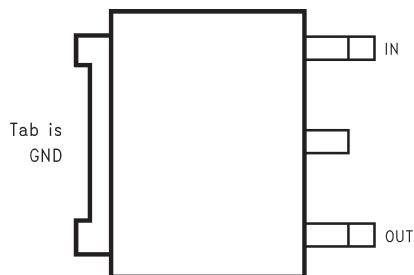
NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

| Changes from Revision K (April 2013) to Revision L                                    | Page     |
|---------------------------------------------------------------------------------------|----------|
| • 已添加 处理额定值表, 特性描述部分, 器件功能模式, 应用和实施部分, 电源相关建议部分, 布局部分, 器件和文档支持部分以及机械、封装和可订购信息部分 ..... | <b>1</b> |

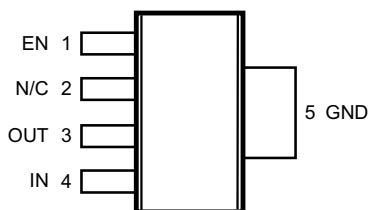
| Changes from Revision J (April 2013) to Revision K         | Page      |
|------------------------------------------------------------|-----------|
| • Changed layout of National Data Sheet to TI format ..... | <b>18</b> |

## 6 Pin Configuration and Functions

**NDP Package  
3-Pin TO-252  
Top View**

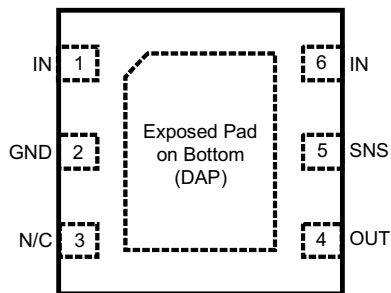


**NDC Package  
5-Pin SOT-223  
Top View**



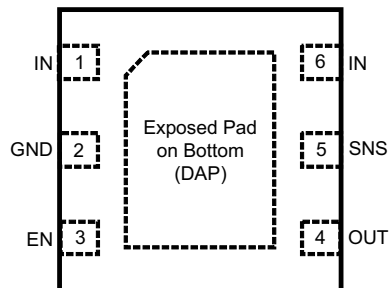
NC - No internal connection

**NGG Package  
6-Pin WSON With Exposed Thermal Pad  
LP38691SD Top View**



NC - No internal connection

**NGG Package  
6-Pin WSON With Exposed Thermal Pad  
LP38693SD Top View**



## Pin Functions

| PIN  |        |      |      |         | I/O | DESCRIPTION                                                                                                                                                                                                                                         |
|------|--------|------|------|---------|-----|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| NAME | TO-252 | WSO  |      | SOT-223 |     |                                                                                                                                                                                                                                                     |
| IN   | 3      | 1, 6 | 1, 6 | 4       | I   | This is the input supply voltage to the regulator. For WSO devices, both $V_{IN}$ pins must be tied together for full current operation (250mA maximum per pin).                                                                                    |
| GND  | TAB    | 2    | 2    | 5       | —   | Circuit ground for the regulator. For the PFM and SOT-223 packages this is thermally connected to the die and functions as a heat sink when the soldered down to a large copper plane.                                                              |
| SNS  | —      | 5    | 5    | —       | I   | WSO Only - Output sense pin allows remote sensing at the load which will eliminate the error in output voltage due to voltage drops caused by the resistance in the traces between the regulator and the load. This pin must be tied to $V_{OUT}$ . |
| EN   | —      | —    | 3    | 1       | I   | The enable pin allows the part to be turned ON and OFF by pulling this pin high or low.                                                                                                                                                             |
| OUT  | 1      | 4    | 4    | 3       | O   | Regulated output voltage                                                                                                                                                                                                                            |
| DAP  | —      | √    | √    | —       | —   | WSO Only - The DAP (Exposed Pad) functions as a thermal connection when soldered to a copper plane. See <a href="#">WSO Mounting</a> section for more information.                                                                                  |

## 7 Specifications

### 7.1 Absolute Maximum Ratings<sup>(1)(2)</sup>

|                                       | MIN                | MAX | UNIT |
|---------------------------------------|--------------------|-----|------|
| Lead Temp. (Soldering, 5 seconds)     |                    | 260 | °C   |
| Power Dissipation <sup>(3)</sup>      | Internally Limited |     | V    |
| V(max) All pins (with respect to GND) | –0.3               | 12  | V    |
| $I_{OUT}$ <sup>(4)</sup>              | Internally Limited |     | V    |
| Junction Temperature                  | –40                | 150 | °C   |

- (1) Absolute maximum ratings indicate limits beyond which damage to the component may occur. Operating ratings indicate conditions for which the device is intended to be functional, but do not ensure specific performance limits. For ensured specifications, see [Electrical Characteristics](#). Specifications do not apply when operating the device outside of its rated operating conditions.
- (2) If Military/Aerospace specified devices are required, please contact the Texas Instruments Sales Office/ Distributors for availability and specifications.
- (3) At elevated temperatures, device power dissipation must be derated based on package thermal resistance and heatsink values (if a heatsink is used). When using the WSO package, refer to *AN-1187 Leadless Leadframe Package (LLP)*, *SNOA401*, and the [WSO Mounting](#) section in this datasheet. If power dissipation causes the junction temperature to exceed specified limits, the device will go into thermal shutdown.
- (4) If used in a dual-supply system where the regulator load is returned to a negative supply, the output pin must be diode clamped to ground.

### 7.2 Handling Ratings: LP3869x

|             | MIN                       | MAX                                                                         | UNIT |
|-------------|---------------------------|-----------------------------------------------------------------------------|------|
| $T_{stg}$   | Storage temperature range |                                                                             | °C   |
| $V_{(ESD)}$ | Electrostatic discharge   | Human body model (HBM), per ANSI/ESDA/JEDEC JS-001, all pins <sup>(1)</sup> | kV   |

- (1) JEDEC document JEP155 states that 500-V HBM allows safe manufacturing with a standard ESD control process.

### 7.3 Handling Ratings: LP3869x-Q1

|             | MIN                       | MAX                                                                         | UNIT |
|-------------|---------------------------|-----------------------------------------------------------------------------|------|
| $T_{stg}$   | Storage temperature range |                                                                             | °C   |
| $V_{(ESD)}$ | Electrostatic discharge   | Human body model (HBM), per ANSI/ESDA/JEDEC JS-001, all pins <sup>(1)</sup> | kV   |

- (1) JEDEC document JEP155 states that 500-V HBM allows safe manufacturing with a standard ESD control process.

## 7.4 Recommended Operating Conditions

|                                      | MIN | NOM | MAX | UNIT |
|--------------------------------------|-----|-----|-----|------|
| V <sub>IN</sub> Supply Voltage       | 2.7 |     | 10  | V    |
| Operating Junction Temperature Range | –40 |     | 125 | °C   |

## 7.5 Thermal Information

| THERMAL METRIC <sup>(1)</sup>   |                                              | LP38691 | LP38693 | LP3869x | UNIT |
|---------------------------------|----------------------------------------------|---------|---------|---------|------|
|                                 |                                              | TO-252  | WSON    | SOT-223 |      |
|                                 |                                              | 3 PINS  | 6 PINS  | 5 PINS  |      |
| R <sub>θJA</sub> <sup>(2)</sup> | Junction-to-ambient thermal resistance       | 50.5    | 50.6    | 68.5    | °C/W |
| R <sub>θJC(top)</sub>           | Junction-to-case (top) thermal resistance    | 52.6    | 44.4    | 52.2    |      |
| R <sub>θJB</sub>                | Junction-to-board thermal resistance         | 29.7    | 24.9    | 13.0    |      |
| ψ <sub>JT</sub>                 | Junction-to-top characterization parameter   | 4.8     | 0.4     | 5.5     |      |
| ψ <sub>JB</sub>                 | Junction-to-board characterization parameter | 29.3    | 25.1    | 12.8    |      |
| R <sub>θJC(bot)</sub>           | Junction-to-case (bottom) thermal resistance | 1.5     | 5.4     | n/a     |      |

(1) For more information about traditional and new thermal metrics, see the *IC Package Thermal Metrics* application report, [SPRA953](#).

(2) Junction-to-ambient thermal resistance, High-K.

## 7.6 Electrical Characteristics

Limits in standard typeface are for T<sub>J</sub> = 25°C. Unless otherwise specified: V<sub>IN</sub> = V<sub>OUT</sub> + 1 V, C<sub>IN</sub> = C<sub>OUT</sub> = 10 μF, I<sub>LOAD</sub> = 10 mA. Min/Max limits are specified through testing, statistical correlation, or design.

| PARAMETER                                                                       | TEST CONDITIONS                                                                                                      | MIN                    | TYP <sup>(1)</sup> | MAX | UNIT              |
|---------------------------------------------------------------------------------|----------------------------------------------------------------------------------------------------------------------|------------------------|--------------------|-----|-------------------|
| V <sub>O</sub> Output Voltage Tolerance                                         |                                                                                                                      | –2.0                   |                    | 2.0 | %V <sub>OUT</sub> |
|                                                                                 | 100 μA < I <sub>L</sub> < 0.5 A<br>V <sub>O</sub> + 1 V ≤ V <sub>IN</sub> ≤ 10 V<br>Full operating temperature range | –4.0                   |                    | 4.0 |                   |
| ΔV <sub>O</sub> /ΔV <sub>IN</sub> Output Voltage Line Regulation <sup>(2)</sup> | V <sub>O</sub> + 0.5 V ≤ V <sub>IN</sub> ≤ 10 V<br>I <sub>L</sub> = 25 mA                                            |                        | 0.03               |     | %V                |
|                                                                                 | V <sub>O</sub> + 0.5 V ≤ V <sub>IN</sub> ≤ 10 V<br>I <sub>L</sub> = 25 mA<br>Full operating temperature range        |                        |                    | 0.1 |                   |
| ΔV <sub>O</sub> /ΔI <sub>L</sub> Output Voltage Load Regulation <sup>(3)</sup>  | 1 mA < I <sub>L</sub> < 0.5 A<br>V <sub>IN</sub> = V <sub>O</sub> + 1 V                                              |                        | 1.8                |     | %A                |
|                                                                                 | 1 mA < I <sub>L</sub> < 0.5 A<br>V <sub>IN</sub> = V <sub>O</sub> + 1 V<br>Full operating temperature range          |                        |                    | 5   |                   |
| V <sub>IN</sub> – V <sub>OUT</sub> Dropout Voltage <sup>(4)</sup>               | (V <sub>O</sub> = 2.5 V)                                                                                             | I <sub>L</sub> = 0.1 A |                    | 80  | mV                |
|                                                                                 |                                                                                                                      | I <sub>L</sub> = 0.5 A |                    | 430 |                   |
|                                                                                 | (V <sub>O</sub> = 2.5 V)<br>Full operating temperature range                                                         | I <sub>L</sub> = 0.1 A |                    | 145 |                   |
|                                                                                 |                                                                                                                      | I <sub>L</sub> = 0.5 A |                    | 725 |                   |
|                                                                                 | (V <sub>O</sub> = 3.3 V)                                                                                             | I <sub>L</sub> = 0.1 A |                    | 65  |                   |
|                                                                                 |                                                                                                                      | I <sub>L</sub> = 0.5 A |                    | 330 |                   |
|                                                                                 | (V <sub>O</sub> = 3.3 V)<br>Full operating temperature range                                                         | I <sub>L</sub> = 0.1 A |                    | 110 |                   |
|                                                                                 |                                                                                                                      | I <sub>L</sub> = 0.5 A |                    | 550 |                   |
|                                                                                 | (V <sub>O</sub> = 5 V)                                                                                               | I <sub>L</sub> = 0.1 A |                    | 45  |                   |
|                                                                                 |                                                                                                                      | I <sub>L</sub> = 0.5 A |                    | 250 |                   |
|                                                                                 | (V <sub>O</sub> = 5 V)<br>Full operating temperature range                                                           | I <sub>L</sub> = 0.1 A |                    | 100 |                   |
|                                                                                 |                                                                                                                      | I <sub>L</sub> = 0.5 A |                    | 450 |                   |

(1) Typical numbers represent the most likely parametric norm for 25°C operation.

(2) Output voltage line regulation is defined as the change in output voltage from nominal value resulting from a change in input voltage.

(3) Output voltage load regulation is defined as the change in output voltage from nominal value as the load current increases from 1 mA to full load.

(4) Dropout voltage is defined as the minimum input to output differential required to maintain the output within 100 mV of nominal value.

## Electrical Characteristics (continued)

Limits in standard typeface are for  $T_J = 25^\circ\text{C}$ . Unless otherwise specified:  $V_{IN} = V_{OUT} + 1\text{ V}$ ,  $C_{IN} = C_{OUT} = 10\text{ }\mu\text{F}$ ,  $I_{LOAD} = 10\text{ mA}$ . Min/Max limits are specified through testing, statistical correlation, or design.

| PARAMETER             |                                             | TEST CONDITIONS                                                                                               | MIN | TYP <sup>(1)</sup> | MAX | UNIT                           |
|-----------------------|---------------------------------------------|---------------------------------------------------------------------------------------------------------------|-----|--------------------|-----|--------------------------------|
| $I_Q$                 | Quiescent Current                           | $V_{IN} \leq 10\text{ V}$ , $I_L = 100\text{ }\mu\text{A} - 0.5\text{ A}$                                     |     | 55                 |     | $\mu\text{A}$                  |
|                       |                                             | $V_{IN} \leq 10\text{ V}$ , $I_L = 100\text{ }\mu\text{A} - 0.5\text{ A}$<br>Full operating temperature range |     |                    | 100 |                                |
|                       |                                             | $V_{EN} \leq 0.4\text{ V}$ , (LP38693 Only)                                                                   |     | 0.001              | 1   |                                |
| $I_L(\text{MIN})$     | Minimum Load Current                        | $V_{IN} - V_O \leq 4\text{ V}$<br>Full operating temperature range                                            |     |                    | 100 |                                |
| $I_{FB}$              | Foldback Current Limit                      | $V_{IN} - V_O > 5\text{ V}$                                                                                   |     | 350                |     | mA                             |
|                       |                                             | $V_{IN} - V_O < 4\text{ V}$                                                                                   |     | 850                |     |                                |
| PSRR                  | Ripple Rejection                            | $V_{IN} = V_O + 2\text{ V(DC)}$ , with 1 V(p-p) / 120 Hz Ripple                                               |     | 55                 |     | dB                             |
| $T_{SD}$              | Thermal Shutdown Activation (Junction Temp) |                                                                                                               |     | 160                |     | $^\circ\text{C}$               |
| $T_{SD}(\text{HYST})$ | Thermal Shutdown Hysteresis (Junction Temp) |                                                                                                               |     | 10                 |     |                                |
| $e_n$                 | Output Noise                                | $\text{BW} = 10\text{ Hz to }10\text{ kHz}$<br>$V_O = 3.3\text{ V}$                                           |     | 0.7                |     | $\mu\text{V}/\sqrt{\text{Hz}}$ |
| $V_O(\text{LEAK})$    | Output Leakage Current                      | $V_O = V_O(\text{NOM}) + 1\text{ V}$ at $10\text{ V}_{IN}$                                                    |     | 0.5                | 12  | $\mu\text{A}$                  |
| $V_{EN}$              | Enable Voltage (LP38693 Only)               | Output = OFF<br>Full operating temperature range                                                              |     |                    | 0.4 | V                              |
|                       |                                             | Output = ON, $V_{IN} = 4\text{ V}$<br>Full operating temperature range                                        | 1.8 |                    |     |                                |
|                       |                                             | Output = ON, $V_{IN} = 6\text{ V}$<br>Full operating temperature range                                        | 3.0 |                    |     |                                |
|                       |                                             | Output = ON, $V_{IN} = 10\text{ V}$<br>Full operating temperature range                                       | 4.0 |                    |     |                                |
| $I_{EN}$              | Enable Pin Leakage (LP38693 Only)           | $V_{EN} = 0\text{ V}$ or $10\text{ V}$ , $V_{IN} = 10\text{ V}$                                               | -1  | 0.001              | 1   | $\mu\text{A}$                  |

## 7.7 Typical Characteristics

Unless otherwise specified:  $T_J = 25^\circ\text{C}$ ,  $C_{IN} = C_{OUT} = 10\ \mu\text{F}$ , Enable pin is tied to  $V_{IN}$  (LP38693 only),  $V_{OUT} = 1.8\ \text{V}$ ,  $V_{IN} = V_{OUT} + 1\ \text{V}$ ,  $I_L = 10\ \text{mA}$ .

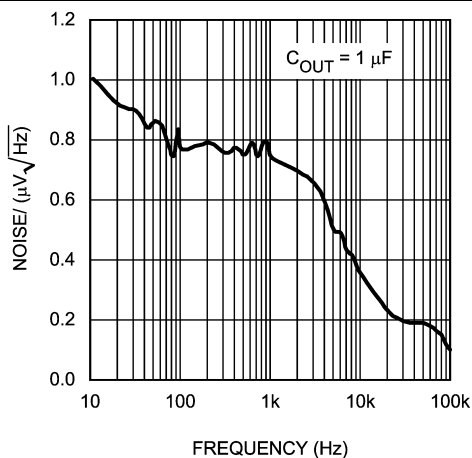


Figure 1. Noise vs Frequency

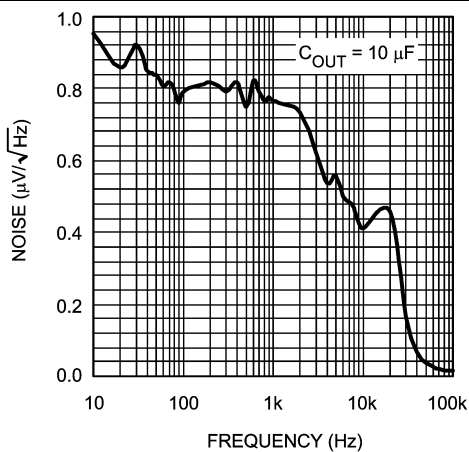


Figure 2. Noise vs Frequency

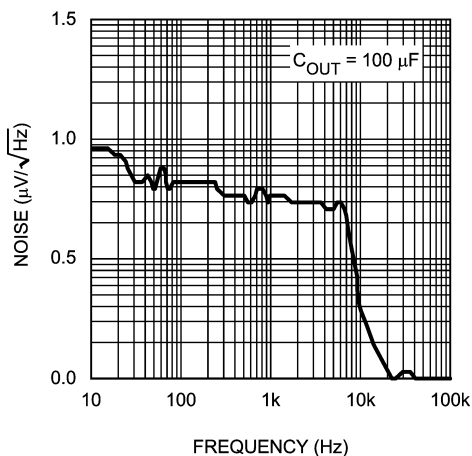


Figure 3. Noise vs Frequency

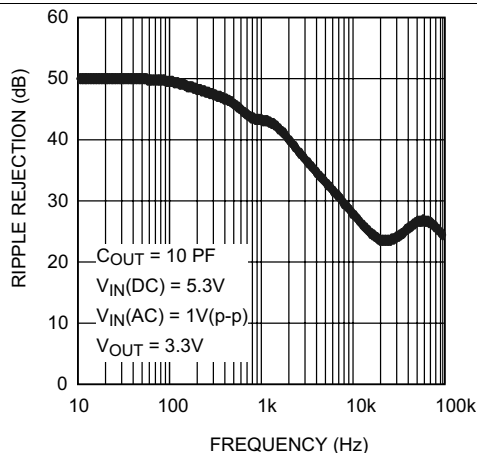


Figure 4. Ripple Rejection

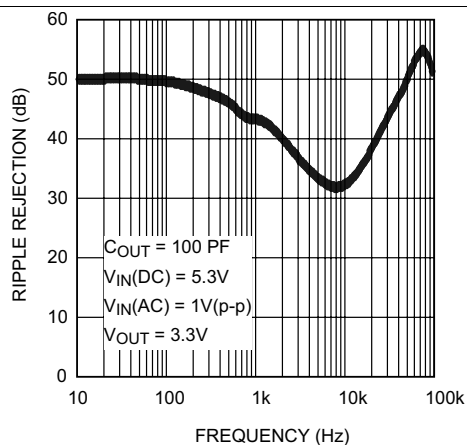


Figure 5. Ripple Rejection

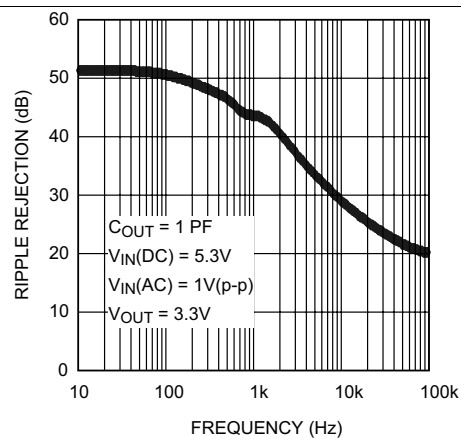
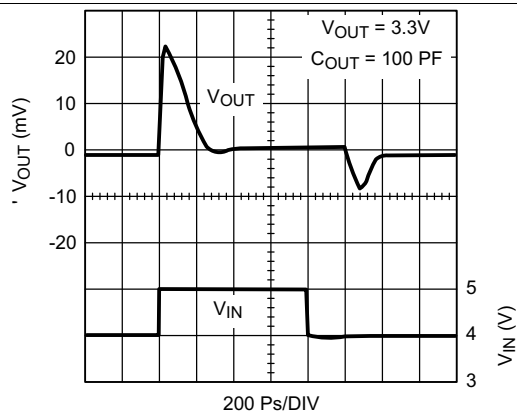


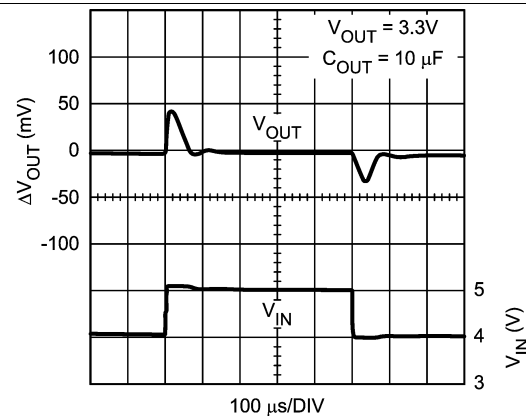
Figure 6. Ripple Rejection

## Typical Characteristics (continued)

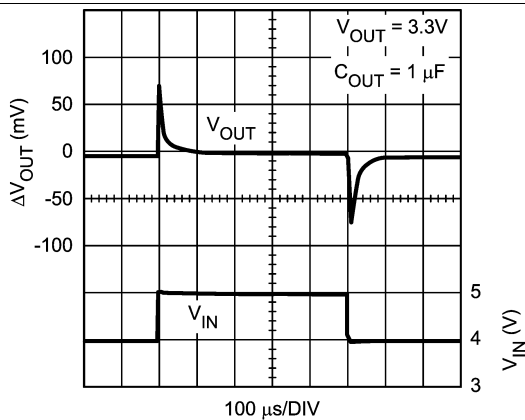
Unless otherwise specified:  $T_J = 25^\circ\text{C}$ ,  $C_{IN} = C_{OUT} = 10\ \mu\text{F}$ , Enable pin is tied to  $V_{IN}$  (LP38693 only),  $V_{OUT} = 1.8\ \text{V}$ ,  $V_{IN} = V_{OUT} + 1\ \text{V}$ ,  $I_L = 10\ \text{mA}$ .



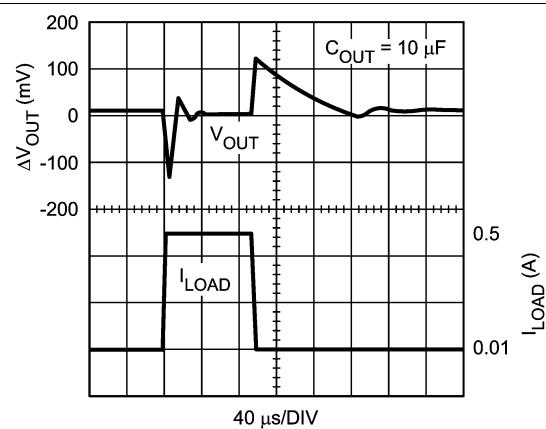
**Figure 7. Line Transient Response**



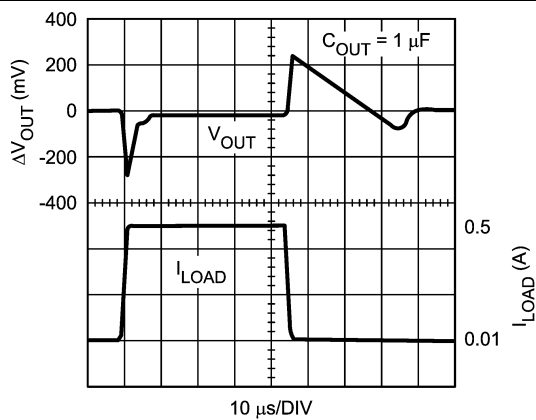
**Figure 8. Line Transient Response**



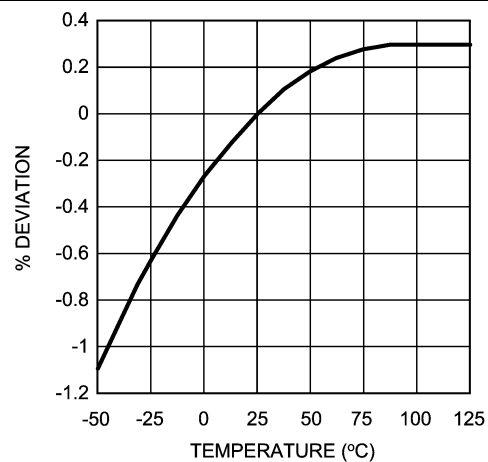
**Figure 9. Line Transient Response**



**Figure 10. Load Transient Response**



**Figure 11. Load Transient Response**



**Figure 12.  $V_{OUT}$  vs Temperature (5.0 V)**

## Typical Characteristics (continued)

Unless otherwise specified:  $T_J = 25^\circ\text{C}$ ,  $C_{IN} = C_{OUT} = 10\ \mu\text{F}$ , Enable pin is tied to  $V_{IN}$  (LP38693 only),  $V_{OUT} = 1.8\ \text{V}$ ,  $V_{IN} = V_{OUT} + 1\ \text{V}$ ,  $I_L = 10\ \text{mA}$ .

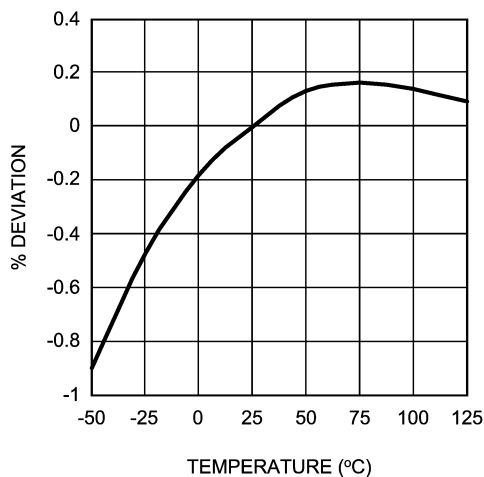


Figure 13.  $V_{OUT}$  vs Temperature (3.3 V)

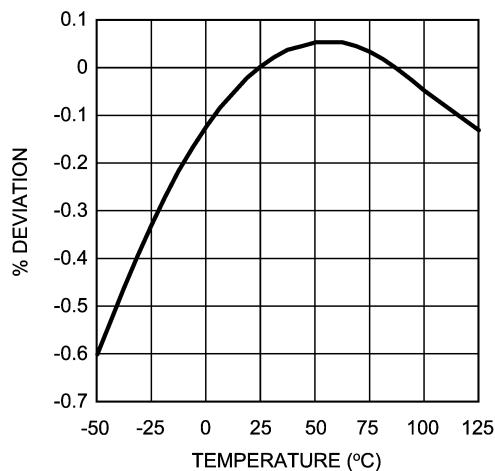


Figure 14.  $V_{OUT}$  vs Temperature (2.5 V)

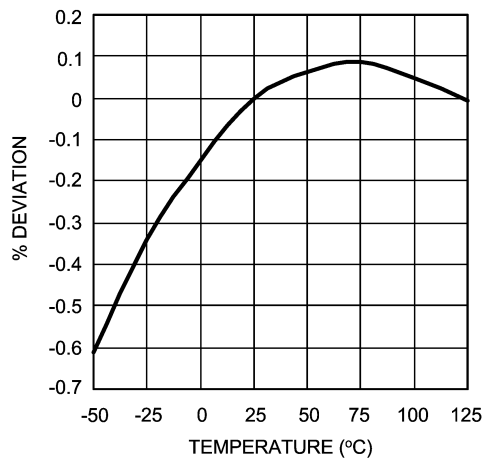


Figure 15.  $V_{OUT}$  vs Temperature (1.8 V)

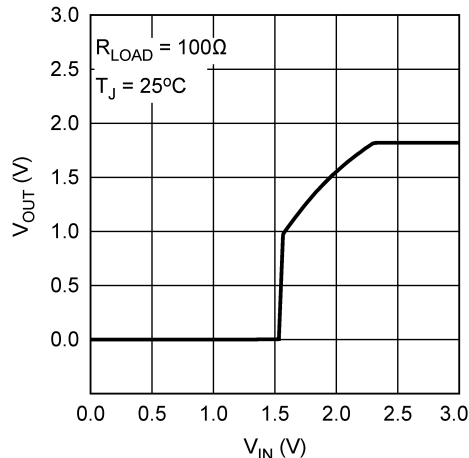


Figure 16.  $V_{OUT}$  vs  $V_{IN}$  (1.8 V)

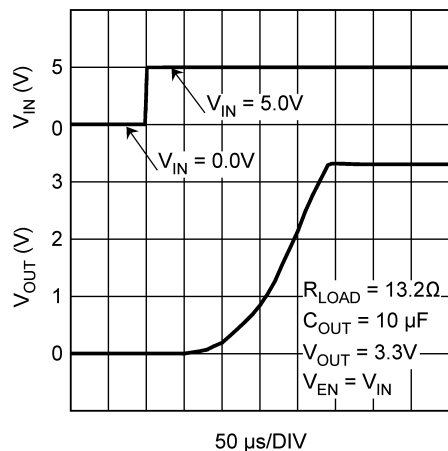


Figure 17.  $V_{OUT}$  vs  $V_{IN}$ , Power-Up

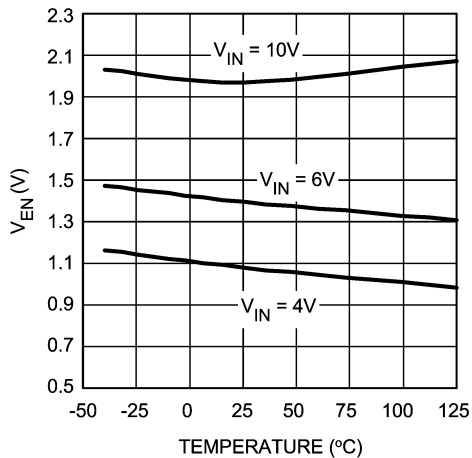
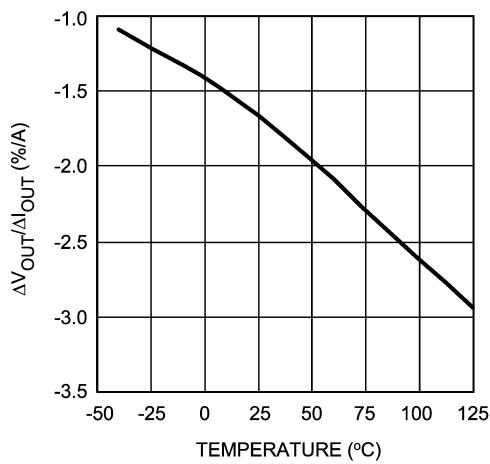


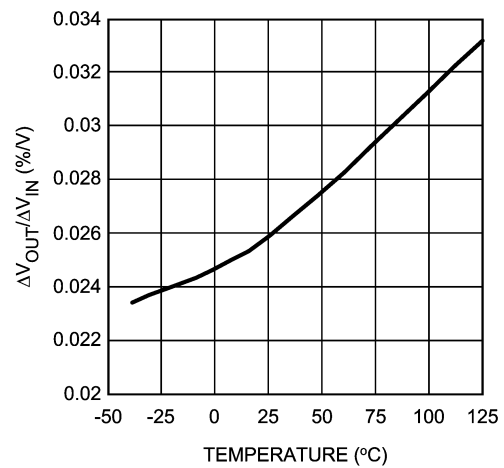
Figure 18. Enable Voltage vs Temperature

## Typical Characteristics (continued)

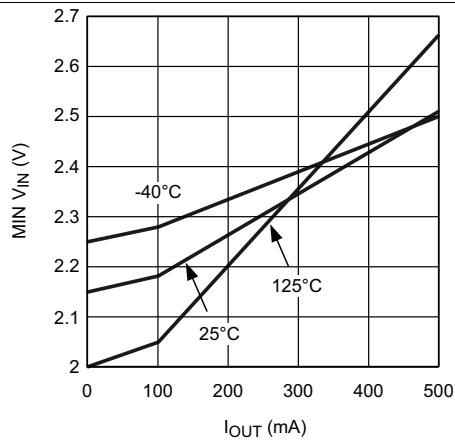
Unless otherwise specified:  $T_J = 25^\circ\text{C}$ ,  $C_{IN} = C_{OUT} = 10\ \mu\text{F}$ , Enable pin is tied to  $V_{IN}$  (LP38693 only),  $V_{OUT} = 1.8\ \text{V}$ ,  $V_{IN} = V_{OUT} + 1\ \text{V}$ ,  $I_L = 10\ \text{mA}$ .



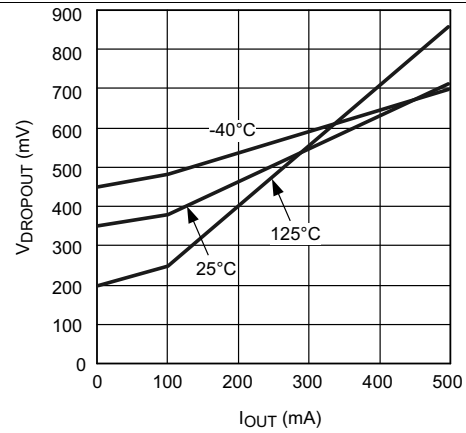
**Figure 19. Load Regulation vs Temperature**



**Figure 20. Line Regulation vs Temperature**



**Figure 21. MIN  $V_{IN}$  vs  $I_{OUT}$**



**Figure 22. Dropout Voltage vs  $I_{OUT}$**

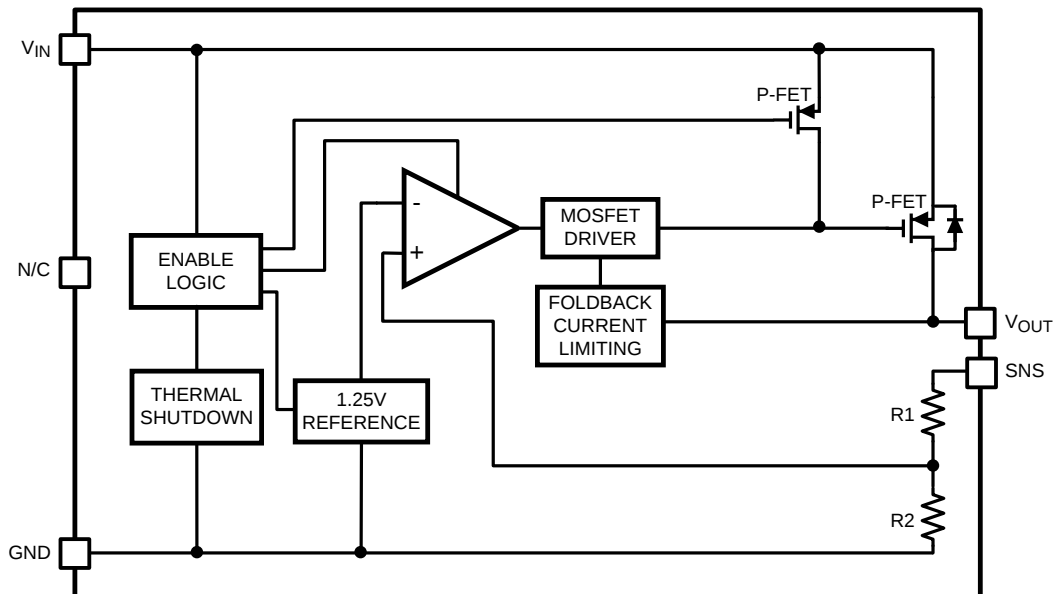
## 8 Detailed Description

### 8.1 Overview

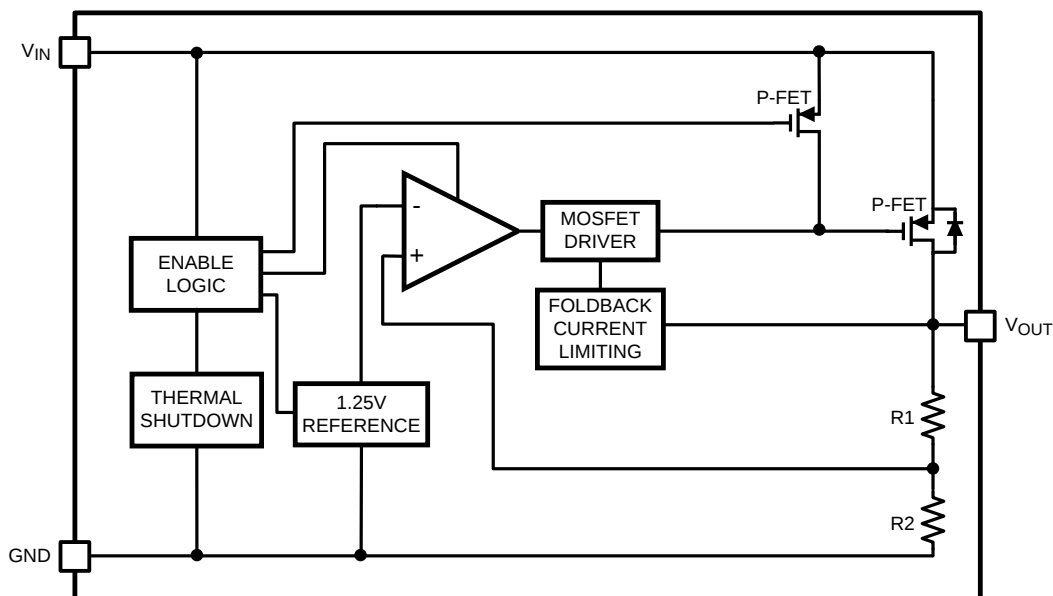
The LP38691/93 are designed to meet the requirements of portable, battery-powered digital systems providing an accurate output voltage with fast start-up. When disabled via a low logic signal at the enable pin (EN), the power consumption is reduced to virtually zero (LP38693 only).

The LP38691/93 will perform well with a single 1- $\mu$ F input capacitor and a single 1- $\mu$ F ceramic output capacitor.

### 8.2 Functional Block Diagrams

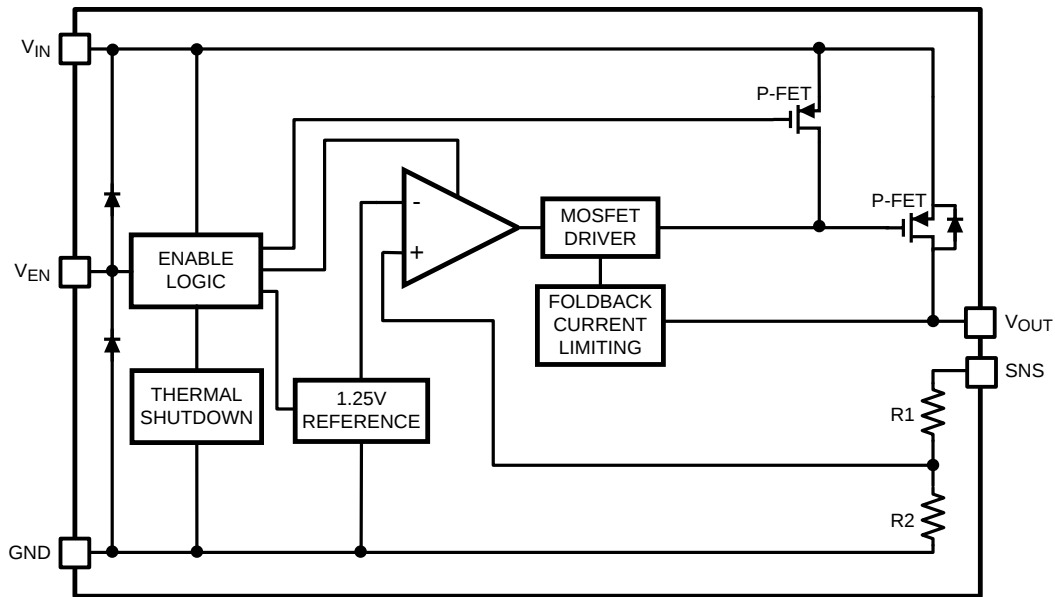


**Figure 23. LP38691 Functional Diagram (WSON)**

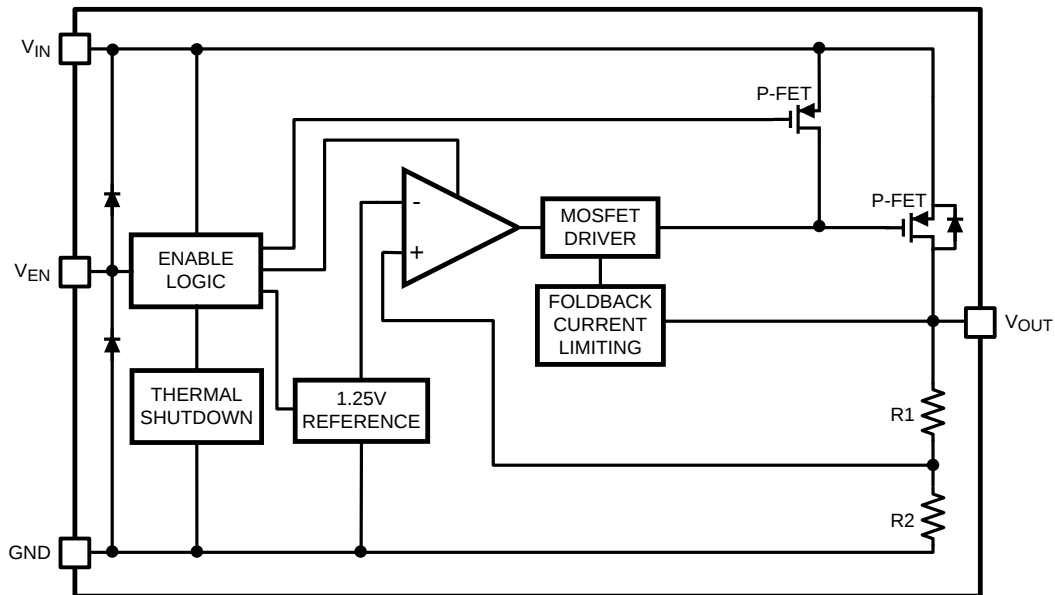


**Figure 24. LP38691 Functional Diagram (TO-252)**

## Functional Block Diagrams (continued)



**Figure 25. LP38693 Functional Diagram (WSON)**



**Figure 26. LP38693 Functional Diagram (SOT-223)**

## 8.3 Feature Description

### 8.3.1 Enable (EN)

The LP38693 has an Enable pin (EN) which allows an external control signal to turn the regulator output On and Off. The Enable On/Off threshold has no hysteresis. The voltage signal must rise and fall cleanly, and promptly, through the ON and OFF voltage thresholds. The EN pin voltage must be higher than the  $V_{EN(MIN)}$  threshold to ensure that the device is fully enabled under all operating conditions. The EN pin voltage must be lower than the  $V_{EN(MAX)}$  threshold to ensure that the device is fully disabled. The EN pin has no internal pullup or pulldown to establish a default condition and, as a result, this pin must be terminated either actively or passively. If the EN pin is driven from a source that actively pulls high and low, the drive voltage should not be allowed to go below ground potential or higher than  $V_{IN}$ . If the application does not require the Enable function, the pin should be connected directly to the  $V_{IN}$  pin.

### 8.3.2 Thermal Overload Protection (TSD)

Thermal Shutdown disables the output when the junction temperature rises to approximately 160°C which allows the device to cool. When the junction temperature cools to approximately 150°C, the output circuitry enables.

Based on power dissipation, thermal resistance, and ambient temperature, the thermal protection circuit may cycle on and off. This thermal cycling limits the dissipation of the regulator and protects it from damage as a result of overheating. The Thermal Shutdown circuitry of the LP38693 has been designed to protect against temporary thermal overload conditions.

The Thermal Shutdown circuitry was not intended to replace proper heat-sinking. Continuously running the LP38693 device into thermal shutdown degrades device reliability.

### 8.3.3 Foldback Current Limiting

Foldback current limiting is built into the LP38691 and LP38693 devices which reduces the amount of output current the part can deliver as the output voltage is reduced. The amount of load current is dependent on the differential voltage between  $V_{IN}$  and  $V_{OUT}$ . Typically, when this differential voltage exceeds 5 V, the load current will limit at about 350 mA. When the  $V_{IN} - V_{OUT}$  differential is reduced below 4 V, load current is limited to about 850 mA.

## 8.4 Device Functional Modes

### 8.4.1 Enable (EN)

The EN pin voltage must be higher than the  $V_{EN(MIN)}$  threshold to ensure that the device is fully enabled under all operating conditions.

### 8.4.2 Minimum Operating Input Voltage ( $V_{IN}$ )

The LP3869x does not include any dedicated UVLO circuitry. The LP3869x internal circuitry is not fully functional until  $V_{IN}$  is at least 2.7 V. The output voltage is not regulated until  $V_{IN} \geq (V_{OUT} + V_{DO})$ , or 2.7 V, whichever is higher.

## 9 Application and Implementation

### NOTE

Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes. Customers should validate and test their design implementation to confirm system functionality.

### 9.1 Application Information

#### 9.1.1 Reverse Voltage

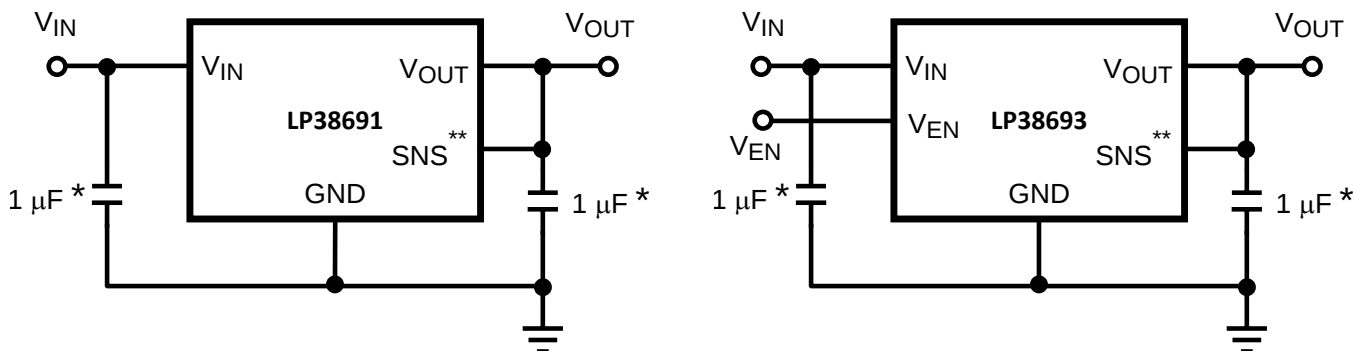
A reverse voltage condition will exist when the voltage at the output pin is higher than the voltage at the input pin. Typically this will happen when  $V_{IN}$  is abruptly taken low and  $C_{OUT}$  continues to hold a sufficient charge such that the input to output voltage becomes reversed. A less common condition is when an alternate voltage source is connected to the output.

There are two possible paths for current to flow from the output pin back to the input during a reverse voltage condition.

1. While  $V_{IN}$  is high enough to keep the control circuitry alive, and the Enable pin (LP38693 only) is above the  $V_{EN(ON)}$  threshold, the control circuitry will attempt to regulate the output voltage. If the input voltage is less than the programmed output voltage, the control circuit will drive the gate of the pass element to the full ON condition. In this condition, reverse current will flow from the output pin to the input pin, limited only by the  $R_{DS(ON)}$  of the pass element and the output to input voltage differential. Discharging an output capacitor up to 1000  $\mu F$  in this manner will not damage the device as the current will rapidly decay. However, continuous reverse current should be avoided. When the Enable pin is low this condition will be prevented.
2. The internal PFET pass element has an inherent parasitic diode. During normal operation, the input voltage is higher than the output voltage and the parasitic diode is reverse biased. However, when  $V_{IN}$  is below the value where the control circuitry is alive, or the Enable pin is low (LP38693 only), and the output voltage is more than 500 mV (typical) above the input voltage the parasitic diode becomes forward biased and current flows from the output pin to the input pin through the diode. The current in the parasitic diode should be limited to less than 1A continuous and 5A peak.

If used in a dual-supply system where the regulator output load is returned to a negative supply, the output pin must be diode clamped to ground to limit the negative voltage transition. A Schottky diode is recommended for this protective clamp.

### 9.2 Typical Application



\* Minimum value required for stability.

\*\*WSO package devices only.

## 9.2.1 Design Requirements

**Table 1. Design Parameters**

| DESIGN PARAMETERS                    | EXAMPLE VALUE                  |
|--------------------------------------|--------------------------------|
| Input voltage range                  | 2.7 V to 10 V                  |
| Output range                         | 1.8 V                          |
| Output current                       | 1 A                            |
| Output capacitor range               | 1 $\mu$ F                      |
| Input and output capacitor ESR range | 5 m $\Omega$ to 500 m $\Omega$ |

## 9.2.2 Detailed Design Procedure

To begin the design process, determine the following:

- Available input voltage range
- Output voltage needed
- Output current needed
- Input and output capacitors

### 9.2.2.1 Power Dissipation and Device Operation

The permissible power dissipation for any package is a measure of the capability of the device to pass heat from the power source, the junctions of the IC, to the ultimate heat sink, the ambient environment. Thus, the power dissipation is dependent on the ambient temperature and the thermal resistance across the various interfaces between the die junction and ambient air.

The maximum allowable power dissipation for the device in a given package can be calculated using [Equation 1](#):

$$P_{D-MAX} = ((T_{J-MAX} - T_A) / R_{\theta JA}) \quad (1)$$

The actual power being dissipated in the device can be represented by [Equation 2](#):

$$P_D = (V_{IN} - V_{OUT}) \times I_{OUT} \quad (2)$$

These two equations establish the relationship between the maximum power dissipation allowed due to thermal consideration, the voltage drop across the device, and the continuous current capability of the device. These two equations should be used to determine the optimum operating conditions for the device in the application.

In applications where lower power dissipation ( $P_D$ ) and/or excellent package thermal resistance ( $R_{\theta JA}$ ) is present, the maximum ambient temperature ( $T_{A-MAX}$ ) may be increased.

In applications where high power dissipation and/or poor package thermal resistance is present, the maximum ambient temperature ( $T_{A-MAX}$ ) may have to be derated.  $T_{A-MAX}$  is dependent on the maximum operating junction temperature ( $T_{J-MAX-OP} = 125^\circ\text{C}$ ), the maximum allowable power dissipation in the device package in the application ( $P_{D-MAX}$ ), and the junction-to ambient thermal resistance of the part/package in the application ( $R_{\theta JA}$ ), as given by [Equation 3](#):

$$T_{A-MAX} = (T_{J-MAX-OP} - (R_{\theta JA} \times P_{D-MAX})) \quad (3)$$

Alternately, if  $T_{A-MAX}$  can not be derated, the  $P_D$  value must be reduced. This can be accomplished by reducing  $V_{IN}$  in the ' $V_{IN}-V_{OUT}$ ' term as long as the minimum  $V_{IN}$  is met, or by reducing the  $I_{OUT}$  term, or by some combination of the two.

### 9.2.2.2 External Capacitors

In common with most regulators, the LP3869x requires external capacitors for regulator stability. The LP3869x is specifically designed for portable applications requiring minimum board space and smallest components. These capacitors must be correctly selected for good performance.

### 9.2.2.3 Input Capacitor

An input capacitor is required for stability. It is recommended that a 1- $\mu$ F capacitor be connected between the LP3869x IN pin and GND pin (this capacitance value may be increased without limit).

This capacitor must be located a distance of not more than 1 cm from the IN pin and returned to a clean analogue ground. Any good quality ceramic, tantalum, or film capacitor may be used at the input.

**Important:** To ensure stable operation it is essential that good PCB design practices are employed to minimize ground impedance and keep input inductance low. If these conditions cannot be met, or if long leads are used to connect the battery or other power source to the LP3869x, then it is recommended that the input capacitor is increased. Also, tantalum capacitors can suffer catastrophic failures due to surge current when connected to a low-impedance source of power (like a battery or a very large capacitor). If a tantalum capacitor is used at the input, it must be ensured by the manufacturer to have a surge current rating sufficient for the application.

There are no requirements for the ESR (equivalent series resistance) on the input capacitor, but tolerance and temperature coefficient must be considered when selecting the capacitor to ensure the capacitance will remain approximately 1  $\mu\text{F}$  over the entire operating temperature range.

#### **9.2.2.4 Output Capacitor**

The LP3869x is designed specifically to work with very small ceramic output capacitors. A 1- $\mu\text{F}$  ceramic capacitor (temperature types Z5U, Y5V or X7R/X5R) with ESR between 5 m $\Omega$  to 500 m $\Omega$ , is suitable in the LP3869x application circuit.

For this device the output capacitor should be connected between the OUT pin and GND pin.

It is also possible to use tantalum or film capacitors at the device output, but these are not as attractive for reasons of size and cost.

The output capacitor must meet the requirement for the minimum value of capacitance and also have an ESR value that is within the range 5 m $\Omega$  to 500 m $\Omega$  for stability.

#### **9.2.2.5 No-Load Stability**

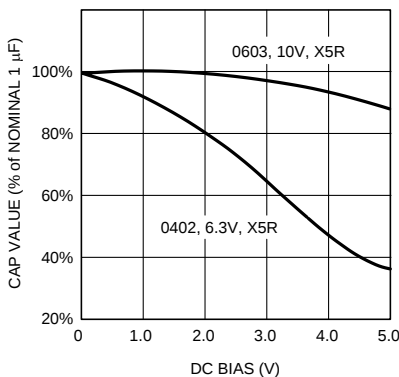
The LP3869x will remain stable and in regulation with no external load. This is an important consideration in some circuits, for example CMOS RAM keep-alive applications.

#### **9.2.2.6 Capacitor Characteristics**

The LP3869x is designed to work with ceramic capacitors on the output to take advantage of the benefits they offer. For capacitance values in the range of 0.47  $\mu\text{F}$  to 4.7  $\mu\text{F}$ , ceramic capacitors are the smallest, least expensive and have the lowest ESR values, thus making them best for eliminating high frequency noise. The ESR of a typical 1- $\mu\text{F}$  ceramic capacitor is in the range of 20 m $\Omega$  to 40 m $\Omega$ , which easily meets the ESR requirement for stability for the LP3869x.

For both input and output capacitors, careful interpretation of the capacitor specification is required to ensure correct device operation. The capacitor value can change greatly, depending on the operating conditions and capacitor type.

In particular, the output capacitor selection should take account of all the capacitor parameters, to ensure that the specification is met within the application. The capacitance can vary with DC bias conditions as well as temperature and frequency of operation. Capacitor values will also show some decrease over time due to aging. The capacitor parameters are also dependent on the particular case size, with smaller sizes giving poorer performance figures in general. As an example, [Figure 27](#) shows a typical graph comparing different capacitor case sizes in a Capacitance vs. DC Bias plot. As shown in the graph, increasing the DC Bias condition can result in the capacitance value falling below the minimum value given in the recommended capacitor specifications table (0.7  $\mu\text{F}$  in this case). Note that the graph shows the capacitance out of specification for the 0402 case size capacitor at higher bias voltages. It is therefore recommended that the capacitor manufacturers' specifications for the nominal value capacitor are consulted for all conditions, as some capacitor sizes (for example, 0402) may not be suitable in the actual application.



**Figure 27. Typical Variation In Capacitance vs DC Bias**

The value of the ceramic capacitor can vary with temperature. The capacitor type X7R, which operates over a temperature range of  $-55^{\circ}\text{C}$  to  $125^{\circ}\text{C}$ , will only vary the capacitance to within  $\pm 15\%$ . The capacitor type X5R has a similar tolerance over a reduced temperature range of  $-55^{\circ}\text{C}$  to  $85^{\circ}\text{C}$ . Many large value ceramic capacitors, larger than  $1\text{ }\mu\text{F}$  are manufactured with Z5U or Y5V temperature characteristics. Their capacitance can drop by more than 50% as the temperature varies from  $25^{\circ}\text{C}$  to  $85^{\circ}\text{C}$ . Therefore, X7R and X5R types are recommended over Z5U and Y5V in applications where the ambient temperature will change significantly above or below  $25^{\circ}\text{C}$ .

Tantalum capacitors are less desirable than ceramic for use as output capacitors because they are more costly when comparing equivalent capacitance and voltage ratings in the  $0.47\text{-}\mu\text{F}$  to  $4.7\text{-}\mu\text{F}$  range.

Another important consideration is that tantalum capacitors have higher ESR values than equivalent size ceramics. This means that while it may be possible to find a tantalum capacitor with an ESR value within the stable range, it would have to be larger in capacitance (which means bigger and more costly) than a ceramic capacitor with the same ESR value. It should also be noted that the ESR of a typical tantalum will increase about 2:1 as the temperature goes from  $25^{\circ}\text{C}$  down to  $-40^{\circ}\text{C}$ , so some guard band must be allowed.

#### 9.2.2.7 RFI/EMI Susceptibility

RFI (radio frequency interference) and EMI (electromagnetic interference) can degrade any integrated circuit's performance because of the small dimensions of the geometries inside the device. In applications where circuit sources are present which generate signals with significant high frequency energy content ( $> 1\text{ MHz}$ ), care must be taken to ensure that this does not affect the IC regulator.

If RFI/EMI noise is present on the input side of the regulator (such as applications where the input source comes from the output of a switching regulator), good ceramic bypass capacitors must be used at the input pin of the IC.

If a load is connected to the IC output which switches at high speed (such as a clock), the high-frequency current pulses required by the load must be supplied by the capacitors on the IC output. Because the bandwidth of the regulator loop is less than  $100\text{ kHz}$ , the control circuitry cannot respond to load changes above that frequency. This means the effective output impedance of the IC at frequencies above  $100\text{ kHz}$  is determined only by the output capacitors.

In applications where the load is switching at high speed, the output of the IC may need RF isolation from the load. It is recommended that some inductance be placed between the output capacitor and the load, and good RF bypass capacitors be placed directly across the load.

PCB layout is also critical in high noise environments, because RFI/EMI is easily radiated directly into PC traces. Noisy circuitry should be isolated from *clean* circuits where possible, and grounded through a separate path. At MHz frequencies, ground planes begin to look inductive and RFI/EMI can cause ground bounce across the ground plane. In multi-layer PCB applications, care should be taken in layout so that noisy power and ground planes do not radiate directly into adjacent layers which carry analog power and ground.

### 9.2.2.8 Output Noise

Noise is specified in two ways: **Spot Noise** or **Output Noise Density** is the RMS sum of all noise sources, measured at the regulator output, at a specific frequency (measured with a 1Hz bandwidth). This type of noise is usually plotted on a curve as a function of frequency. **Total Output Noise** or **Broad-Band Noise** is the RMS sum of spot noise over a specified bandwidth, usually several decades of frequencies.

Attention should be paid to the units of measurement. Spot noise is measured in units  $\mu\text{V}/\text{root-Hz}$  or  $\text{nV}/\text{root-Hz}$  and total output noise is measured in  $\mu\text{V}(\text{rms})$ .

The primary source of noise in low-dropout regulators is the internal reference. Noise can be reduced in two ways: by increasing the transistor area or by increasing the current drawn by the internal reference. Increasing the area will decrease the chance of fitting the die into a smaller package. Increasing the current drawn by the internal reference increases the total supply current (ground pin current).

### 9.2.3 Application Curves

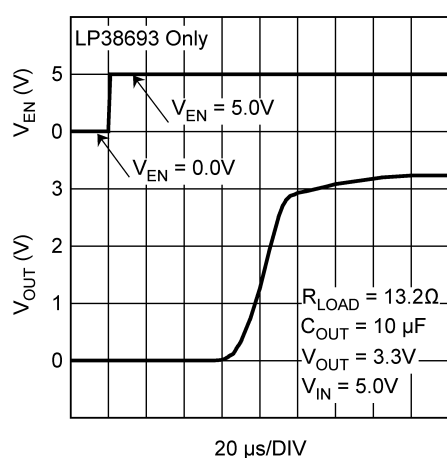


Figure 28.  $V_{\text{OUT}}$  vs  $V_{\text{EN}}$ , ON (LP38693 Only)

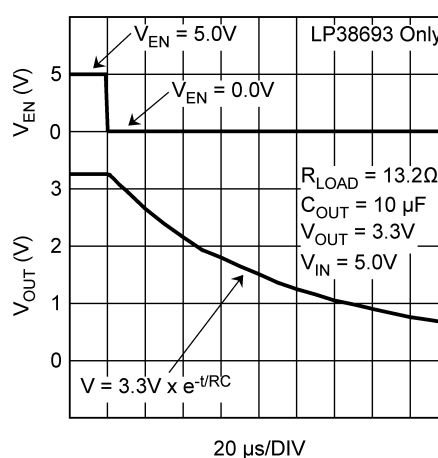


Figure 29.  $V_{\text{OUT}}$  vs  $V_{\text{EN}}$ , OFF (LP38693 Only)

## 10 Power Supply Recommendations

The LP3869x is designed to operate from an input supply voltage range of 2.7 V to 10 V. The input supply should be well regulated and free of spurious noise. To ensure that the LP3869x output voltage is well regulated, the input supply should be at least  $V_{OUT} + 0.5\text{ V}$ , or 2.7 V, whichever is higher. A minimum capacitor value of 1- $\mu\text{F}$  is required to be within 1 cm of the IN pin.

## 11 Layout

### 11.1 Layout Guidelines

The dynamic performance of the LP3869x is dependent on the layout of the PCB. PCB layout practices that are adequate for typical LDOs may degrade the load regulation, PSRR, noise, or transient performance of the LP3869x.

Best performance is achieved by placing  $C_{IN}$  and  $C_{OUT}$  on the same side of the PCB as the LP3869x, and as close as is practical to the package. The ground connections for  $C_{IN}$  and  $C_{OUT}$  should be back to the LP3869x ground pin using as wide, and as short, a copper trace as is practical.

Connections using long trace lengths, narrow trace widths, and/or connections through vias should be avoided. These will add parasitic inductances and resistance that results in inferior performance especially during transient conditions.

A Ground Plane, either on the opposite side of a two-layer PCB, or embedded in a multi-layer PCB, is strongly recommended. This Ground Plane serves two purposes:

- Provides a circuit reference plane to assure accuracy.
- Provides a thermal plane to remove heat from the LP3869x WSON package through thermal vias under the package DAP.

#### 11.1.1 WSON Mounting

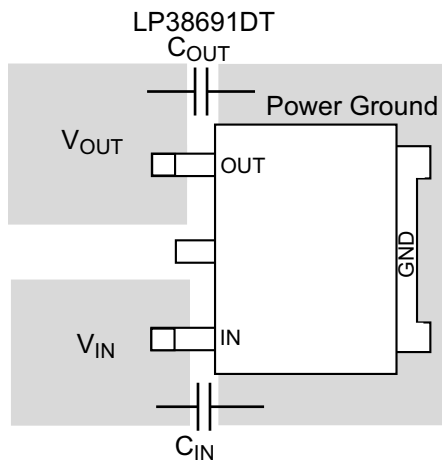
The NGG0006A (No Pullback) 6-Lead WSON package requires specific mounting techniques which are detailed in the TI *AN-1187 Application Report* [SNOA401](#). Referring to the section PCB Design Recommendations (Page 5), it should be noted that the pad style which should be used with the WSON package is the NSMD (non-solder mask defined) type. Additionally, it is recommended the PCB terminal pads to be 0.2-mm longer than the package pads to create a solder fillet to improve reliability and inspection.

The input current is split between two  $V_{IN}$  pins, 1 and 6. The two  $V_{IN}$  pins must be connected together to ensure that the device can meet all specifications at the rated current.

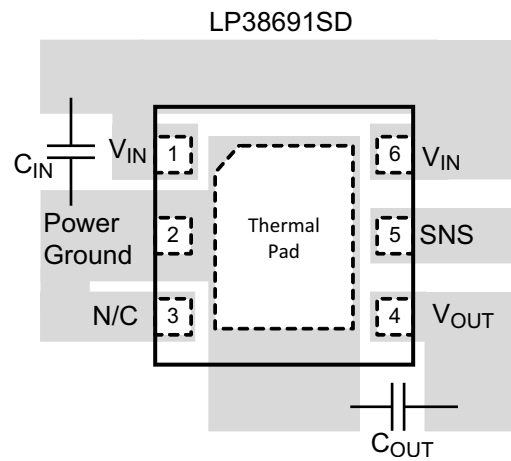
The thermal dissipation of the WSON package is directly related to the printed circuit board construction and the amount of additional copper area connected to the DAP.

The DAP (exposed pad) on the bottom of the WSON package is connected to the die substrate with a conductive die attach adhesive. The DAP has no direct electrical (wire) connection to any of the pins. There is a parasitic PN junction between the die substrate and the device ground. As such, it is strongly recommend that the DAP be connected directly to the ground at device lead 2 (that is, GND). Alternately, but not recommended, the DAP may be left floating (that is, no electrical connection). The DAP must not be connected to any potential other than ground.

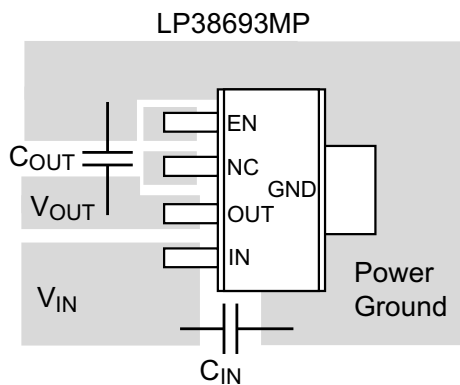
## 11.2 Layout Example



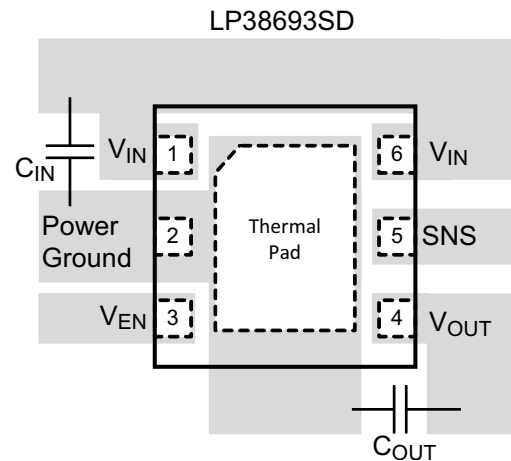
**Figure 30. TO-252 Package**



**Figure 31. WSON LP38691SD Package**



**Figure 32. SOT-223 Package**



**Figure 33. WSON LP38693SD Package**

## 12 器件和文档支持

### 12.1 相关链接

以下表格列出了快速访问链接。范围包括技术文档、支持与社区资源、工具和软件，并且可以快速访问样片或购买链接。

**表 2. 相关链接**

| 器件         | 产品文件夹                 | 样片与购买                 | 技术文档                  | 工具与软件                 | 支持与社区                 |
|------------|-----------------------|-----------------------|-----------------------|-----------------------|-----------------------|
| LP38691    | <a href="#">请单击此处</a> | <a href="#">请单击此处</a> | <a href="#">请单击此处</a> | <a href="#">请单击此处</a> | <a href="#">请单击此处</a> |
| LP38693    | <a href="#">请单击此处</a> | <a href="#">请单击此处</a> | <a href="#">请单击此处</a> | <a href="#">请单击此处</a> | <a href="#">请单击此处</a> |
| LP38691-Q1 | <a href="#">请单击此处</a> | <a href="#">请单击此处</a> | <a href="#">请单击此处</a> | <a href="#">请单击此处</a> | <a href="#">请单击此处</a> |
| LP38693-Q1 | <a href="#">请单击此处</a> | <a href="#">请单击此处</a> | <a href="#">请单击此处</a> | <a href="#">请单击此处</a> | <a href="#">请单击此处</a> |

### 12.2 商标

All trademarks are the property of their respective owners.

### 12.3 静电放电警告



这些装置包含有限的内置 ESD 保护。存储或装卸时，应将导线一起截短或将装置放置于导电泡棉中，以防止 MOS 门极遭受静电损伤。

### 12.4 术语表

[SLYZ022](#) — TI 术语表。

这份术语表列出并解释术语、首字母缩略词和定义。

## 13 机械封装和可订购信息

以下页中包括机械封装和可订购信息。 这些信息是针对指定器件可提供的最新数据。 这些数据会在无通知且不对本文档进行修订的情况下发生改变。 欲获得该数据表的浏览器版本，请查阅左侧的导航栏。

## PACKAGING INFORMATION

| Orderable Device     | Status<br>(1) | Package Type | Package<br>Drawing | Pins | Package<br>Qty | Eco Plan<br>(2)     | Lead finish/<br>Ball material<br>(6) | MSL Peak Temp<br>(3) | Op Temp (°C) | Device Marking<br>(4/5) | Samples                 |
|----------------------|---------------|--------------|--------------------|------|----------------|---------------------|--------------------------------------|----------------------|--------------|-------------------------|-------------------------|
| LP38691DT-1.8        | NRND          | TO-252       | NDP                | 3    | 75             | Non-RoHS<br>& Green | Call TI                              | Level-1-235C-UNLIM   | -40 to 125   | LP38691<br>DT-1.8       |                         |
| LP38691DT-1.8/NOPB   | ACTIVE        | TO-252       | NDP                | 3    | 75             | RoHS & Green        | SN                                   | Level-2-260C-1 YEAR  | -40 to 125   | LP38691<br>DT-1.8       | <a href="#">Samples</a> |
| LP38691DT-2.5/NOPB   | ACTIVE        | TO-252       | NDP                | 3    | 75             | RoHS & Green        | SN                                   | Level-2-260C-1 YEAR  | -40 to 125   | LP38691<br>DT-2.5       | <a href="#">Samples</a> |
| LP38691DT-3.3        | NRND          | TO-252       | NDP                | 3    | 75             | Non-RoHS<br>& Green | Call TI                              | Level-1-235C-UNLIM   | -40 to 125   | LP38691<br>DT-3.3       |                         |
| LP38691DT-3.3/NOPB   | ACTIVE        | TO-252       | NDP                | 3    | 75             | RoHS & Green        | SN                                   | Level-2-260C-1 YEAR  | -40 to 125   | LP38691<br>DT-3.3       | <a href="#">Samples</a> |
| LP38691DT-5.0/NOPB   | ACTIVE        | TO-252       | NDP                | 3    | 75             | RoHS & Green        | SN                                   | Level-2-260C-1 YEAR  | -40 to 125   | LP38691<br>DT-5.0       | <a href="#">Samples</a> |
| LP38691DTX-1.8/NOPB  | ACTIVE        | TO-252       | NDP                | 3    | 2500           | RoHS & Green        | SN                                   | Level-2-260C-1 YEAR  | -40 to 125   | LP38691<br>DT-1.8       | <a href="#">Samples</a> |
| LP38691DTX-2.5/NOPB  | ACTIVE        | TO-252       | NDP                | 3    | 2500           | RoHS & Green        | SN                                   | Level-2-260C-1 YEAR  | -40 to 125   | LP38691<br>DT-2.5       | <a href="#">Samples</a> |
| LP38691DTX-3.3/NOPB  | ACTIVE        | TO-252       | NDP                | 3    | 2500           | RoHS & Green        | SN                                   | Level-2-260C-1 YEAR  | -40 to 125   | LP38691<br>DT-3.3       | <a href="#">Samples</a> |
| LP38691DTX-5.0/NOPB  | ACTIVE        | TO-252       | NDP                | 3    | 2500           | RoHS & Green        | SN                                   | Level-2-260C-1 YEAR  | -40 to 125   | LP38691<br>DT-5.0       | <a href="#">Samples</a> |
| LP38691QSD-1.8/NOPB  | ACTIVE        | WSO          | NGG                | 6    | 1000           | RoHS & Green        | SN                                   | Level-1-260C-UNLIM   | -40 to 125   | L256B                   | <a href="#">Samples</a> |
| LP38691QSD-2.5/NOPB  | ACTIVE        | WSO          | NGG                | 6    | 1000           | RoHS & Green        | SN                                   | Level-1-260C-UNLIM   | -40 to 125   | L257B                   | <a href="#">Samples</a> |
| LP38691QSD-3.3/NOPB  | ACTIVE        | WSO          | NGG                | 6    | 1000           | RoHS & Green        | SN                                   | Level-1-260C-UNLIM   | -40 to 125   | L258B                   | <a href="#">Samples</a> |
| LP38691QSD-5.0/NOPB  | ACTIVE        | WSO          | NGG                | 6    | 1000           | RoHS & Green        | SN                                   | Level-1-260C-UNLIM   | -40 to 125   | L259B                   | <a href="#">Samples</a> |
| LP38691QSDX-1.8/NOPB | ACTIVE        | WSO          | NGG                | 6    | 4500           | RoHS & Green        | SN                                   | Level-1-260C-UNLIM   | -40 to 125   | L256B                   | <a href="#">Samples</a> |
| LP38691QSDX-2.5/NOPB | ACTIVE        | WSO          | NGG                | 6    | 4500           | RoHS & Green        | SN                                   | Level-1-260C-UNLIM   | -40 to 125   | L257B                   | <a href="#">Samples</a> |
| LP38691QSDX-3.3/NOPB | ACTIVE        | WSO          | NGG                | 6    | 4500           | RoHS & Green        | SN                                   | Level-1-260C-UNLIM   | -40 to 125   | L258B                   | <a href="#">Samples</a> |
| LP38691QSDX-5.0/NOPB | ACTIVE        | WSO          | NGG                | 6    | 4500           | RoHS & Green        | SN                                   | Level-1-260C-UNLIM   | -40 to 125   | L259B                   | <a href="#">Samples</a> |

| Orderable Device     | Status<br>(1) | Package Type | Package<br>Drawing | Pins | Package<br>Qty | Eco Plan<br>(2)     | Lead finish/<br>Ball material<br>(6) | MSL Peak Temp<br>(3) | Op Temp (°C) | Device Marking<br>(4/5) | Samples                 |
|----------------------|---------------|--------------|--------------------|------|----------------|---------------------|--------------------------------------|----------------------|--------------|-------------------------|-------------------------|
| LP38691SD-1.8/NOPB   | ACTIVE        | WSON         | NGG                | 6    | 1000           | RoHS & Green        | NIPDAU   SN                          | Level-1-260C-UNLIM   | -40 to 125   | L118B                   | <a href="#">Samples</a> |
| LP38691SD-2.5/NOPB   | ACTIVE        | WSON         | NGG                | 6    | 1000           | RoHS & Green        | NIPDAU   SN                          | Level-1-260C-UNLIM   | -40 to 125   | L119B                   | <a href="#">Samples</a> |
| LP38691SD-3.3/NOPB   | ACTIVE        | WSON         | NGG                | 6    | 1000           | RoHS & Green        | NIPDAU   SN                          | Level-1-260C-UNLIM   | -40 to 125   | L120B                   | <a href="#">Samples</a> |
| LP38691SD-5.0/NOPB   | ACTIVE        | WSON         | NGG                | 6    | 1000           | RoHS & Green        | NIPDAU   SN                          | Level-1-260C-UNLIM   | -40 to 125   | L121B                   | <a href="#">Samples</a> |
| LP38691SDX-1.8/NOPB  | ACTIVE        | WSON         | NGG                | 6    | 4500           | RoHS & Green        | SN                                   | Level-1-260C-UNLIM   | -40 to 125   | L118B                   | <a href="#">Samples</a> |
| LP38691SDX-3.3/NOPB  | ACTIVE        | WSON         | NGG                | 6    | 4500           | RoHS & Green        | SN                                   | Level-1-260C-UNLIM   | -40 to 125   | L120B                   | <a href="#">Samples</a> |
| LP38691SDX-5.0/NOPB  | ACTIVE        | WSON         | NGG                | 6    | 4500           | RoHS & Green        | NIPDAU   SN                          | Level-1-260C-UNLIM   | -40 to 125   | L121B                   | <a href="#">Samples</a> |
| LP38693MP-1.8/NOPB   | ACTIVE        | SOT-223      | NDC                | 5    | 1000           | RoHS & Green        | SN                                   | Level-1-260C-UNLIM   | -40 to 125   | LJVB                    | <a href="#">Samples</a> |
| LP38693MP-2.5/NOPB   | ACTIVE        | SOT-223      | NDC                | 5    | 1000           | RoHS & Green        | SN                                   | Level-1-260C-UNLIM   | -40 to 125   | LJXB                    | <a href="#">Samples</a> |
| LP38693MP-3.3        | NRND          | SOT-223      | NDC                | 5    | 1000           | Non-RoHS<br>& Green | Call TI                              | Level-1-260C-UNLIM   | -40 to 125   | LJYB                    |                         |
| LP38693MP-3.3/NOPB   | ACTIVE        | SOT-223      | NDC                | 5    | 1000           | RoHS & Green        | SN                                   | Level-1-260C-UNLIM   | -40 to 125   | LJYB                    | <a href="#">Samples</a> |
| LP38693MP-5.0/NOPB   | ACTIVE        | SOT-223      | NDC                | 5    | 1000           | RoHS & Green        | SN                                   | Level-1-260C-UNLIM   | -40 to 125   | LJZB                    | <a href="#">Samples</a> |
| LP38693MPX-1.8/NOPB  | ACTIVE        | SOT-223      | NDC                | 5    | 2000           | RoHS & Green        | SN                                   | Level-1-260C-UNLIM   | -40 to 125   | LJVB                    | <a href="#">Samples</a> |
| LP38693MPX-2.5/NOPB  | ACTIVE        | SOT-223      | NDC                | 5    | 2000           | RoHS & Green        | SN                                   | Level-1-260C-UNLIM   | -40 to 125   | LJXB                    | <a href="#">Samples</a> |
| LP38693MPX-3.3/NOPB  | ACTIVE        | SOT-223      | NDC                | 5    | 2000           | RoHS & Green        | SN                                   | Level-1-260C-UNLIM   | -40 to 125   | LJYB                    | <a href="#">Samples</a> |
| LP38693MPX-5.0/NOPB  | ACTIVE        | SOT-223      | NDC                | 5    | 2000           | RoHS & Green        | SN                                   | Level-1-260C-UNLIM   | -40 to 125   | LJZB                    | <a href="#">Samples</a> |
| LP38693QSD-1.8/NOPB  | ACTIVE        | WSON         | NGG                | 6    | 1000           | RoHS & Green        | SN                                   | Level-1-260C-UNLIM   | -40 to 125   | L260B                   | <a href="#">Samples</a> |
| LP38693QSD-2.5/NOPB  | ACTIVE        | WSON         | NGG                | 6    | 1000           | RoHS & Green        | SN                                   | Level-1-260C-UNLIM   | -40 to 125   | L261B                   | <a href="#">Samples</a> |
| LP38693QSD-3.3/NOPB  | ACTIVE        | WSON         | NGG                | 6    | 1000           | RoHS & Green        | SN                                   | Level-1-260C-UNLIM   | -40 to 125   | L262B                   | <a href="#">Samples</a> |
| LP38693QSD-5.0/NOPB  | ACTIVE        | WSON         | NGG                | 6    | 1000           | RoHS & Green        | SN                                   | Level-1-260C-UNLIM   | -40 to 125   | L263B                   | <a href="#">Samples</a> |
| LP38693QSDX-1.8/NOPB | ACTIVE        | WSON         | NGG                | 6    | 4500           | RoHS & Green        | SN                                   | Level-1-260C-UNLIM   | -40 to 125   | L260B                   | <a href="#">Samples</a> |

| Orderable Device     | Status<br>(1) | Package Type | Package<br>Drawing | Pins | Package<br>Qty | Eco Plan<br>(2)     | Lead finish/<br>Ball material<br>(6) | MSL Peak Temp<br>(3) | Op Temp (°C) | Device Marking<br>(4/5) | Samples                 |
|----------------------|---------------|--------------|--------------------|------|----------------|---------------------|--------------------------------------|----------------------|--------------|-------------------------|-------------------------|
| LP38693QSDX-2.5/NOPB | ACTIVE        | WSON         | NGG                | 6    | 4500           | RoHS & Green        | SN                                   | Level-1-260C-UNLIM   | -40 to 125   | L261B                   | <a href="#">Samples</a> |
| LP38693QSDX-3.3/NOPB | ACTIVE        | WSON         | NGG                | 6    | 4500           | RoHS & Green        | SN                                   | Level-1-260C-UNLIM   | -40 to 125   | L262B                   | <a href="#">Samples</a> |
| LP38693QSDX-5.0/NOPB | ACTIVE        | WSON         | NGG                | 6    | 4500           | RoHS & Green        | SN                                   | Level-1-260C-UNLIM   | -40 to 125   | L263B                   | <a href="#">Samples</a> |
| LP38693SD-1.8        | NRND          | WSON         | NGG                | 6    | 1000           | Non-RoHS<br>& Green | Call TI                              | Level-1-260C-UNLIM   | -40 to 125   | L128B                   |                         |
| LP38693SD-1.8/NOPB   | ACTIVE        | WSON         | NGG                | 6    | 1000           | RoHS & Green        | NIPDAU   SN                          | Level-1-260C-UNLIM   | -40 to 125   | L128B                   | <a href="#">Samples</a> |
| LP38693SD-2.5/NOPB   | ACTIVE        | WSON         | NGG                | 6    | 1000           | RoHS & Green        | SN                                   | Level-1-260C-UNLIM   | -40 to 125   | L129B                   | <a href="#">Samples</a> |
| LP38693SD-3.3        | NRND          | WSON         | NGG                | 6    | 1000           | Non-RoHS<br>& Green | Call TI                              | Level-1-260C-UNLIM   | -40 to 125   | L130B                   |                         |
| LP38693SD-3.3/NOPB   | ACTIVE        | WSON         | NGG                | 6    | 1000           | RoHS & Green        | NIPDAU   SN                          | Level-1-260C-UNLIM   | -40 to 125   | L130B                   | <a href="#">Samples</a> |
| LP38693SD-5.0/NOPB   | ACTIVE        | WSON         | NGG                | 6    | 1000           | RoHS & Green        | NIPDAU   SN                          | Level-1-260C-UNLIM   | -40 to 125   | L131B                   | <a href="#">Samples</a> |
| LP38693SDX-3.3/NOPB  | ACTIVE        | WSON         | NGG                | 6    | 4500           | RoHS & Green        | NIPDAU   SN                          | Level-1-260C-UNLIM   | -40 to 125   | L130B                   | <a href="#">Samples</a> |
| LP38693SDX-5.0/NOPB  | ACTIVE        | WSON         | NGG                | 6    | 4500           | RoHS & Green        | SN                                   | Level-1-260C-UNLIM   | -40 to 125   | L131B                   | <a href="#">Samples</a> |

(1) The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) **RoHS:** TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

**RoHS Exempt:** TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

**Green:** TI defines "Green" to mean the content of Chlorine (Cl) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

(3) MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

<sup>(4)</sup> There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

<sup>(5)</sup> Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

<sup>(6)</sup> Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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**OTHER QUALIFIED VERSIONS OF LP38691, LP38691-Q1, LP38693, LP38693-Q1 :**

- Catalog : [LP38691](#), [LP38693](#)
- Automotive : [LP38691-Q1](#), [LP38693-Q1](#)

**NOTE: Qualified Version Definitions:**

- Catalog - TI's standard catalog product
- Automotive - Q100 devices qualified for high-reliability automotive applications targeting zero defects

## TAPE AND REEL INFORMATION

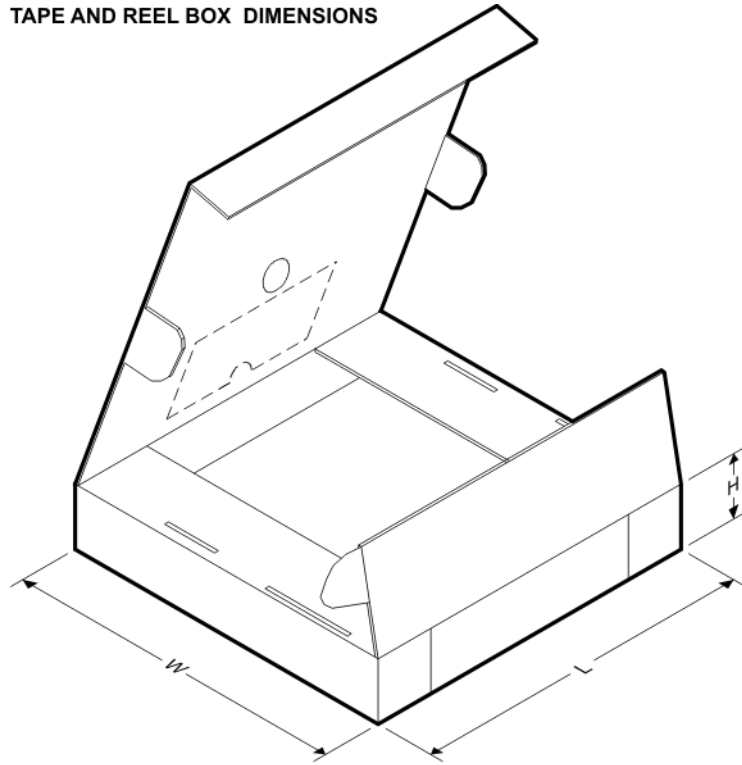


\*All dimensions are nominal

| Device               | Package Type | Package Drawing | Pins | SPQ  | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|----------------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| LP38691DTX-1.8/NOPB  | TO-252       | NDP             | 3    | 2500 | 330.0              | 16.4               | 6.9     | 10.5    | 2.7     | 8.0     | 16.0   | Q2            |
| LP38691DTX-2.5/NOPB  | TO-252       | NDP             | 3    | 2500 | 330.0              | 16.4               | 6.9     | 10.5    | 2.7     | 8.0     | 16.0   | Q2            |
| LP38691DTX-3.3/NOPB  | TO-252       | NDP             | 3    | 2500 | 330.0              | 16.4               | 6.9     | 10.5    | 2.7     | 8.0     | 16.0   | Q2            |
| LP38691DTX-5.0/NOPB  | TO-252       | NDP             | 3    | 2500 | 330.0              | 16.4               | 6.9     | 10.5    | 2.7     | 8.0     | 16.0   | Q2            |
| LP38691QSD-1.8/NOPB  | WSO          | NGG             | 6    | 1000 | 178.0              | 12.4               | 3.3     | 3.3     | 1.0     | 8.0     | 12.0   | Q1            |
| LP38691QSD-2.5/NOPB  | WSO          | NGG             | 6    | 1000 | 178.0              | 12.4               | 3.3     | 3.3     | 1.0     | 8.0     | 12.0   | Q1            |
| LP38691QSD-3.3/NOPB  | WSO          | NGG             | 6    | 1000 | 178.0              | 12.4               | 3.3     | 3.3     | 1.0     | 8.0     | 12.0   | Q1            |
| LP38691QSD-5.0/NOPB  | WSO          | NGG             | 6    | 1000 | 178.0              | 12.4               | 3.3     | 3.3     | 1.0     | 8.0     | 12.0   | Q1            |
| LP38691QSDX-1.8/NOPB | WSO          | NGG             | 6    | 4500 | 330.0              | 12.4               | 3.3     | 3.3     | 1.0     | 8.0     | 12.0   | Q1            |
| LP38691QSDX-2.5/NOPB | WSO          | NGG             | 6    | 4500 | 330.0              | 12.4               | 3.3     | 3.3     | 1.0     | 8.0     | 12.0   | Q1            |
| LP38691QSDX-3.3/NOPB | WSO          | NGG             | 6    | 4500 | 330.0              | 12.4               | 3.3     | 3.3     | 1.0     | 8.0     | 12.0   | Q1            |
| LP38691QSDX-5.0/NOPB | WSO          | NGG             | 6    | 4500 | 330.0              | 12.4               | 3.3     | 3.3     | 1.0     | 8.0     | 12.0   | Q1            |
| LP38691SD-1.8/NOPB   | WSO          | NGG             | 6    | 1000 | 180.0              | 12.4               | 3.3     | 3.3     | 1.0     | 8.0     | 12.0   | Q1            |
| LP38691SD-2.5/NOPB   | WSO          | NGG             | 6    | 1000 | 180.0              | 12.4               | 3.3     | 3.3     | 1.0     | 8.0     | 12.0   | Q1            |
| LP38691SD-3.3/NOPB   | WSO          | NGG             | 6    | 1000 | 180.0              | 12.4               | 3.3     | 3.3     | 1.0     | 8.0     | 12.0   | Q1            |
| LP38691SD-5.0/NOPB   | WSO          | NGG             | 6    | 1000 | 180.0              | 12.4               | 3.3     | 3.3     | 1.0     | 8.0     | 12.0   | Q1            |
| LP38691SDX-1.8/NOPB  | WSO          | NGG             | 6    | 4500 | 330.0              | 12.4               | 3.3     | 3.3     | 1.0     | 8.0     | 12.0   | Q1            |
| LP38691SDX-3.3/NOPB  | WSO          | NGG             | 6    | 4500 | 330.0              | 12.4               | 3.3     | 3.3     | 1.0     | 8.0     | 12.0   | Q1            |

| Device               | Package Type | Package Drawing | Pins | SPQ  | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|----------------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| LP38691SDX-5.0/NOPB  | WSO          | NGG             | 6    | 4500 | 330.0              | 12.4               | 3.3     | 3.3     | 1.0     | 8.0     | 12.0   | Q1            |
| LP38693MP-1.8/NOPB   | SOT-223      | NDC             | 5    | 1000 | 330.0              | 16.4               | 7.0     | 7.5     | 2.2     | 12.0    | 16.0   | Q3            |
| LP38693MP-2.5/NOPB   | SOT-223      | NDC             | 5    | 1000 | 330.0              | 16.4               | 7.0     | 7.5     | 2.2     | 12.0    | 16.0   | Q3            |
| LP38693MP-3.3        | SOT-223      | NDC             | 5    | 1000 | 330.0              | 16.4               | 7.0     | 7.5     | 2.2     | 12.0    | 16.0   | Q3            |
| LP38693MP-3.3/NOPB   | SOT-223      | NDC             | 5    | 1000 | 330.0              | 16.4               | 7.0     | 7.5     | 2.2     | 12.0    | 16.0   | Q3            |
| LP38693MP-5.0/NOPB   | SOT-223      | NDC             | 5    | 1000 | 330.0              | 16.4               | 7.0     | 7.5     | 2.2     | 12.0    | 16.0   | Q3            |
| LP38693MPX-1.8/NOPB  | SOT-223      | NDC             | 5    | 2000 | 330.0              | 16.4               | 7.0     | 7.5     | 2.2     | 12.0    | 16.0   | Q3            |
| LP38693MPX-2.5/NOPB  | SOT-223      | NDC             | 5    | 2000 | 330.0              | 16.4               | 7.0     | 7.5     | 2.2     | 12.0    | 16.0   | Q3            |
| LP38693MPX-3.3/NOPB  | SOT-223      | NDC             | 5    | 2000 | 330.0              | 16.4               | 7.0     | 7.5     | 2.2     | 12.0    | 16.0   | Q3            |
| LP38693MPX-5.0/NOPB  | SOT-223      | NDC             | 5    | 2000 | 330.0              | 16.4               | 7.0     | 7.5     | 2.2     | 12.0    | 16.0   | Q3            |
| LP38693QSD-1.8/NOPB  | WSO          | NGG             | 6    | 1000 | 178.0              | 12.4               | 3.3     | 3.3     | 1.0     | 8.0     | 12.0   | Q1            |
| LP38693QSD-2.5/NOPB  | WSO          | NGG             | 6    | 1000 | 178.0              | 12.4               | 3.3     | 3.3     | 1.0     | 8.0     | 12.0   | Q1            |
| LP38693QSD-3.3/NOPB  | WSO          | NGG             | 6    | 1000 | 178.0              | 12.4               | 3.3     | 3.3     | 1.0     | 8.0     | 12.0   | Q1            |
| LP38693QSD-5.0/NOPB  | WSO          | NGG             | 6    | 1000 | 178.0              | 12.4               | 3.3     | 3.3     | 1.0     | 8.0     | 12.0   | Q1            |
| LP38693QSDX-1.8/NOPB | WSO          | NGG             | 6    | 4500 | 330.0              | 12.4               | 3.3     | 3.3     | 1.0     | 8.0     | 12.0   | Q1            |
| LP38693QSDX-2.5/NOPB | WSO          | NGG             | 6    | 4500 | 330.0              | 12.4               | 3.3     | 3.3     | 1.0     | 8.0     | 12.0   | Q1            |
| LP38693QSDX-3.3/NOPB | WSO          | NGG             | 6    | 4500 | 330.0              | 12.4               | 3.3     | 3.3     | 1.0     | 8.0     | 12.0   | Q1            |
| LP38693QSDX-5.0/NOPB | WSO          | NGG             | 6    | 4500 | 330.0              | 12.4               | 3.3     | 3.3     | 1.0     | 8.0     | 12.0   | Q1            |
| LP38693SD-1.8        | WSO          | NGG             | 6    | 1000 | 178.0              | 12.4               | 3.3     | 3.3     | 1.0     | 8.0     | 12.0   | Q1            |
| LP38693SD-1.8/NOPB   | WSO          | NGG             | 6    | 1000 | 180.0              | 12.4               | 3.3     | 3.3     | 1.0     | 8.0     | 12.0   | Q1            |
| LP38693SD-2.5/NOPB   | WSO          | NGG             | 6    | 1000 | 178.0              | 12.4               | 3.3     | 3.3     | 1.0     | 8.0     | 12.0   | Q1            |
| LP38693SD-3.3        | WSO          | NGG             | 6    | 1000 | 178.0              | 12.4               | 3.3     | 3.3     | 1.0     | 8.0     | 12.0   | Q1            |
| LP38693SD-3.3/NOPB   | WSO          | NGG             | 6    | 1000 | 178.0              | 12.4               | 3.3     | 3.3     | 1.0     | 8.0     | 12.0   | Q1            |
| LP38693SD-3.3/NOPB   | WSO          | NGG             | 6    | 1000 | 180.0              | 12.4               | 3.3     | 3.3     | 1.0     | 8.0     | 12.0   | Q1            |
| LP38693SD-5.0/NOPB   | WSO          | NGG             | 6    | 1000 | 178.0              | 12.4               | 3.3     | 3.3     | 1.0     | 8.0     | 12.0   | Q1            |
| LP38693SD-5.0/NOPB   | WSO          | NGG             | 6    | 1000 | 180.0              | 12.4               | 3.3     | 3.3     | 1.0     | 8.0     | 12.0   | Q1            |
| LP38693SDX-3.3/NOPB  | WSO          | NGG             | 6    | 4500 | 330.0              | 12.4               | 3.3     | 3.3     | 1.0     | 8.0     | 12.0   | Q1            |
| LP38693SDX-5.0/NOPB  | WSO          | NGG             | 6    | 4500 | 330.0              | 12.4               | 3.3     | 3.3     | 1.0     | 8.0     | 12.0   | Q1            |

## TAPE AND REEL BOX DIMENSIONS



\*All dimensions are nominal

| Device               | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|----------------------|--------------|-----------------|------|------|-------------|------------|-------------|
| LP38691DTX-1.8/NOPB  | TO-252       | NDP             | 3    | 2500 | 853.0       | 449.0      | 35.0        |
| LP38691DTX-2.5/NOPB  | TO-252       | NDP             | 3    | 2500 | 853.0       | 449.0      | 35.0        |
| LP38691DTX-3.3/NOPB  | TO-252       | NDP             | 3    | 2500 | 853.0       | 449.0      | 35.0        |
| LP38691DTX-5.0/NOPB  | TO-252       | NDP             | 3    | 2500 | 853.0       | 449.0      | 35.0        |
| LP38691QSD-1.8/NOPB  | WSO          | NGG             | 6    | 1000 | 208.0       | 191.0      | 35.0        |
| LP38691QSD-2.5/NOPB  | WSO          | NGG             | 6    | 1000 | 208.0       | 191.0      | 35.0        |
| LP38691QSD-3.3/NOPB  | WSO          | NGG             | 6    | 1000 | 208.0       | 191.0      | 35.0        |
| LP38691QSD-5.0/NOPB  | WSO          | NGG             | 6    | 1000 | 208.0       | 191.0      | 35.0        |
| LP38691QSDX-1.8/NOPB | WSO          | NGG             | 6    | 4500 | 367.0       | 367.0      | 35.0        |
| LP38691QSDX-2.5/NOPB | WSO          | NGG             | 6    | 4500 | 367.0       | 367.0      | 35.0        |
| LP38691QSDX-3.3/NOPB | WSO          | NGG             | 6    | 4500 | 367.0       | 367.0      | 35.0        |
| LP38691QSDX-5.0/NOPB | WSO          | NGG             | 6    | 4500 | 367.0       | 367.0      | 35.0        |
| LP38691SD-1.8/NOPB   | WSO          | NGG             | 6    | 1000 | 200.0       | 183.0      | 25.0        |
| LP38691SD-2.5/NOPB   | WSO          | NGG             | 6    | 1000 | 200.0       | 183.0      | 25.0        |
| LP38691SD-3.3/NOPB   | WSO          | NGG             | 6    | 1000 | 200.0       | 183.0      | 25.0        |
| LP38691SD-5.0/NOPB   | WSO          | NGG             | 6    | 1000 | 200.0       | 183.0      | 25.0        |
| LP38691SDX-1.8/NOPB  | WSO          | NGG             | 6    | 4500 | 367.0       | 367.0      | 35.0        |
| LP38691SDX-3.3/NOPB  | WSO          | NGG             | 6    | 4500 | 367.0       | 367.0      | 35.0        |
| LP38691SDX-5.0/NOPB  | WSO          | NGG             | 6    | 4500 | 346.0       | 346.0      | 35.0        |
| LP38693MP-1.8/NOPB   | SOT-223      | NDC             | 5    | 1000 | 367.0       | 367.0      | 35.0        |

| Device               | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|----------------------|--------------|-----------------|------|------|-------------|------------|-------------|
| LP38693MP-2.5/NOPB   | SOT-223      | NDC             | 5    | 1000 | 367.0       | 367.0      | 35.0        |
| LP38693MP-3.3        | SOT-223      | NDC             | 5    | 1000 | 367.0       | 367.0      | 35.0        |
| LP38693MP-3.3/NOPB   | SOT-223      | NDC             | 5    | 1000 | 367.0       | 367.0      | 35.0        |
| LP38693MP-5.0/NOPB   | SOT-223      | NDC             | 5    | 1000 | 367.0       | 367.0      | 35.0        |
| LP38693MPX-1.8/NOPB  | SOT-223      | NDC             | 5    | 2000 | 367.0       | 367.0      | 35.0        |
| LP38693MPX-2.5/NOPB  | SOT-223      | NDC             | 5    | 2000 | 367.0       | 367.0      | 35.0        |
| LP38693MPX-3.3/NOPB  | SOT-223      | NDC             | 5    | 2000 | 367.0       | 367.0      | 35.0        |
| LP38693MPX-5.0/NOPB  | SOT-223      | NDC             | 5    | 2000 | 367.0       | 367.0      | 35.0        |
| LP38693QSD-1.8/NOPB  | WSO          | NGG             | 6    | 1000 | 208.0       | 191.0      | 35.0        |
| LP38693QSD-2.5/NOPB  | WSO          | NGG             | 6    | 1000 | 208.0       | 191.0      | 35.0        |
| LP38693QSD-3.3/NOPB  | WSO          | NGG             | 6    | 1000 | 208.0       | 191.0      | 35.0        |
| LP38693QSD-5.0/NOPB  | WSO          | NGG             | 6    | 1000 | 208.0       | 191.0      | 35.0        |
| LP38693QSDX-1.8/NOPB | WSO          | NGG             | 6    | 4500 | 367.0       | 367.0      | 35.0        |
| LP38693QSDX-2.5/NOPB | WSO          | NGG             | 6    | 4500 | 367.0       | 367.0      | 35.0        |
| LP38693QSDX-3.3/NOPB | WSO          | NGG             | 6    | 4500 | 367.0       | 367.0      | 35.0        |
| LP38693QSDX-5.0/NOPB | WSO          | NGG             | 6    | 4500 | 367.0       | 367.0      | 35.0        |
| LP38693SD-1.8        | WSO          | NGG             | 6    | 1000 | 208.0       | 191.0      | 35.0        |
| LP38693SD-1.8/NOPB   | WSO          | NGG             | 6    | 1000 | 200.0       | 183.0      | 25.0        |
| LP38693SD-2.5/NOPB   | WSO          | NGG             | 6    | 1000 | 208.0       | 191.0      | 35.0        |
| LP38693SD-3.3        | WSO          | NGG             | 6    | 1000 | 208.0       | 191.0      | 35.0        |
| LP38693SD-3.3/NOPB   | WSO          | NGG             | 6    | 1000 | 208.0       | 191.0      | 35.0        |
| LP38693SD-3.3/NOPB   | WSO          | NGG             | 6    | 1000 | 200.0       | 183.0      | 25.0        |
| LP38693SD-5.0/NOPB   | WSO          | NGG             | 6    | 1000 | 208.0       | 191.0      | 35.0        |
| LP38693SD-5.0/NOPB   | WSO          | NGG             | 6    | 1000 | 200.0       | 183.0      | 25.0        |
| LP38693SDX-3.3/NOPB  | WSO          | NGG             | 6    | 4500 | 346.0       | 346.0      | 35.0        |
| LP38693SDX-5.0/NOPB  | WSO          | NGG             | 6    | 4500 | 367.0       | 367.0      | 35.0        |

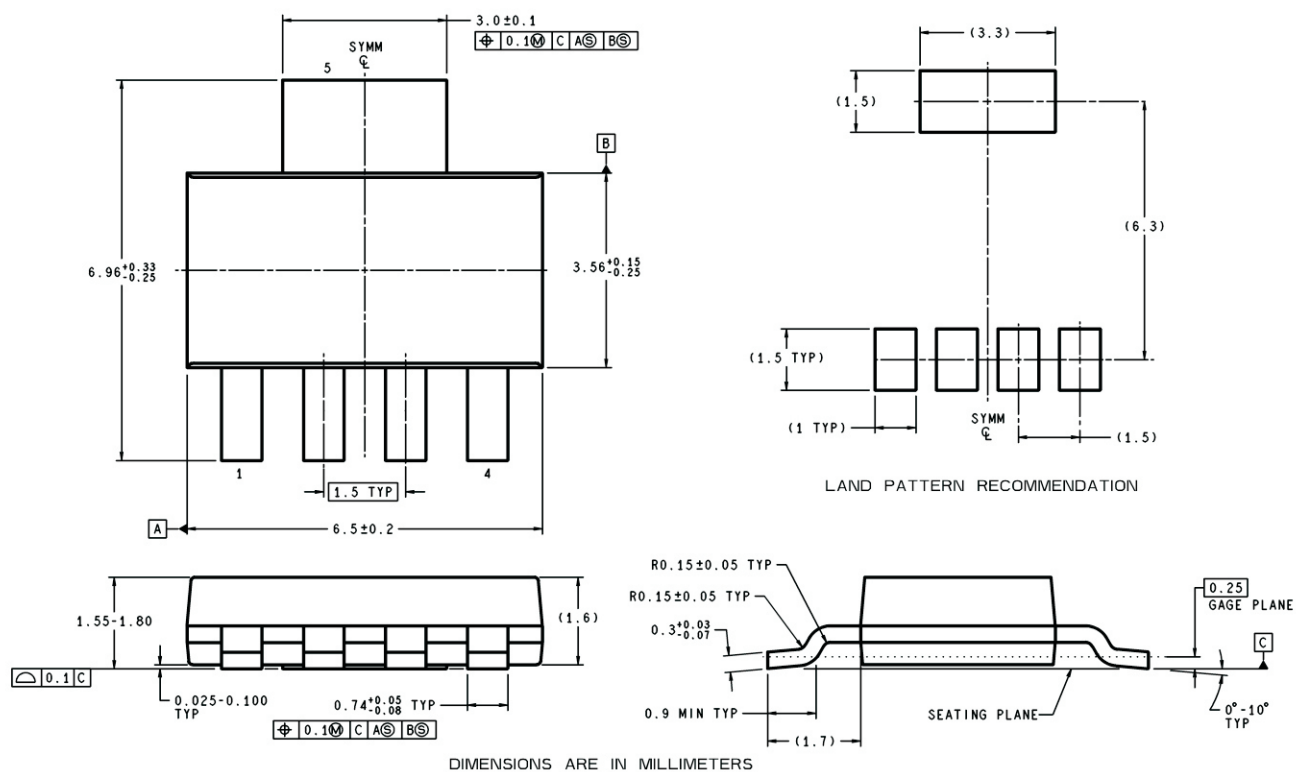
## TUBE



\*All dimensions are nominal

| Device             | Package Name | Package Type | Pins | SPQ | L (mm) | W (mm) | T (μm) | B (mm) |
|--------------------|--------------|--------------|------|-----|--------|--------|--------|--------|
| LP38691DT-1.8      | NDP          | TO-252       | 3    | 75  | 508    | 20     | 4165.6 | 3.1    |
| LP38691DT-1.8      | NDP          | TO-252       | 3    | 75  | 508    | 20     | 4165.6 | 3.1    |
| LP38691DT-1.8/NOPB | NDP          | TO-252       | 3    | 75  | 508    | 20     | 4165.6 | 3.1    |
| LP38691DT-2.5/NOPB | NDP          | TO-252       | 3    | 75  | 508    | 20     | 4165.6 | 3.1    |
| LP38691DT-3.3      | NDP          | TO-252       | 3    | 75  | 508    | 20     | 4165.6 | 3.1    |
| LP38691DT-3.3      | NDP          | TO-252       | 3    | 75  | 508    | 20     | 4165.6 | 3.1    |
| LP38691DT-3.3/NOPB | NDP          | TO-252       | 3    | 75  | 508    | 20     | 4165.6 | 3.1    |
| LP38691DT-5.0/NOPB | NDP          | TO-252       | 3    | 75  | 508    | 20     | 4165.6 | 3.1    |

NDC0005A



MP05A (Rev A)



**TO-252 - 2.55 mm max height**

## TRANSISTOR OUTLINE

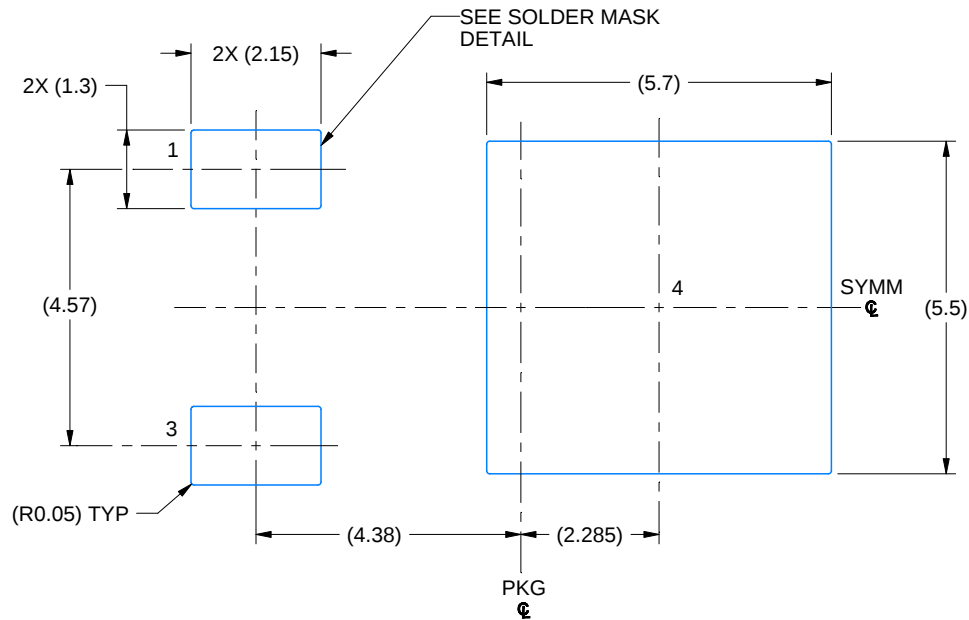


1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. Reference JEDEC registration TO-252.

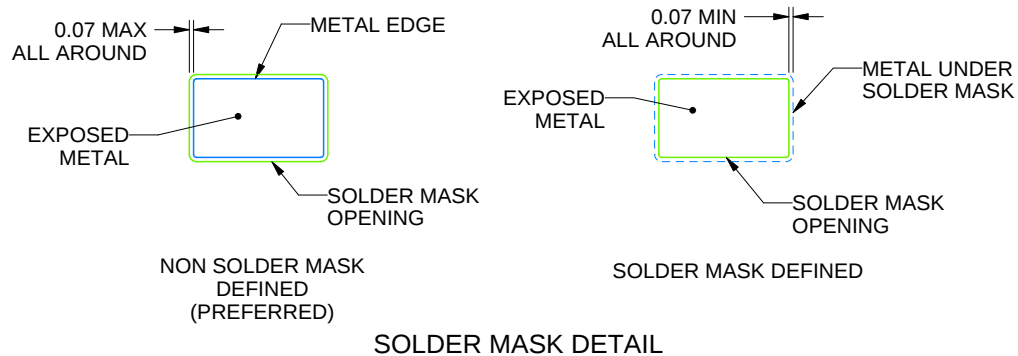
NDP0003B

**TO-252 - 2.55 mm max height**

## TRANSISTOR OUTLINE



LAND PATTERN EXAMPLE  
EXPOSED METAL SHOWN  
SCALE: 8X



4219870/A 03/2018

NOTES: (continued)

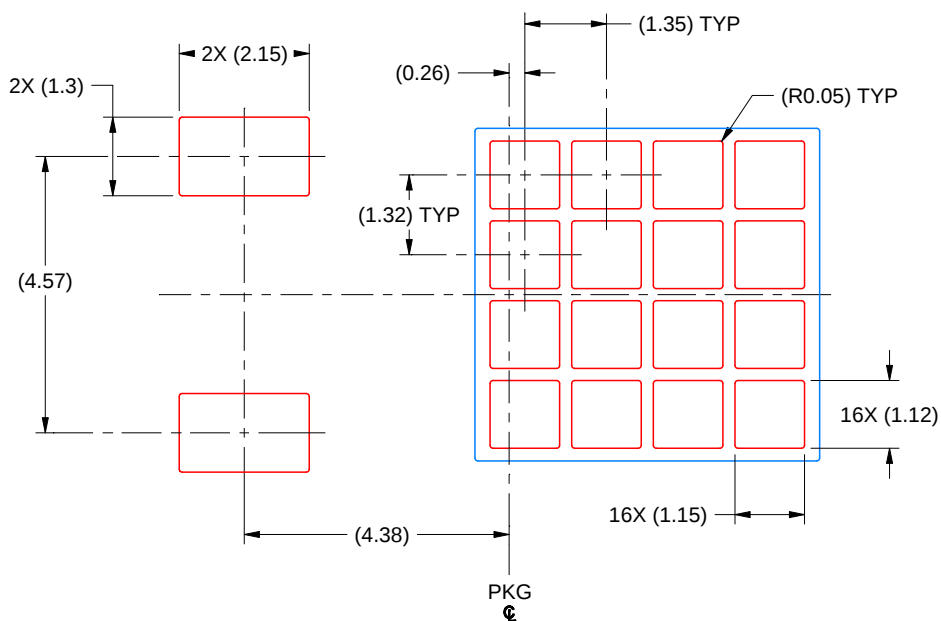
4. This package is designed to be soldered to a thermal pad on the board. For more information, see Texas Instruments literature numbers SLMA002 ([www.ti.com/lit/slm002](http://www.ti.com/lit/slm002)) and SLMA004 ([www.ti.com/lit/slma004](http://www.ti.com/lit/slma004)).
5. Vias are optional depending on application, refer to device data sheet. It is recommended that vias under paste be filled, plugged or tented.

# EXAMPLE STENCIL DESIGN

NDP0003B

TO-252 - 2.55 mm max height

TRANSISTOR OUTLINE

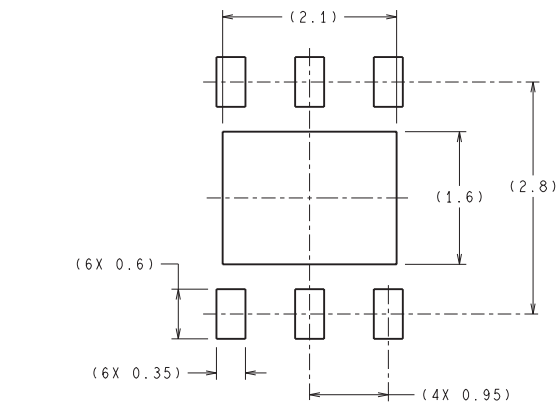


SOLDER PASTE EXAMPLE  
BASED ON 0.125 MM THICK STENCIL  
SCALE: 8X

4219870/A 03/2018

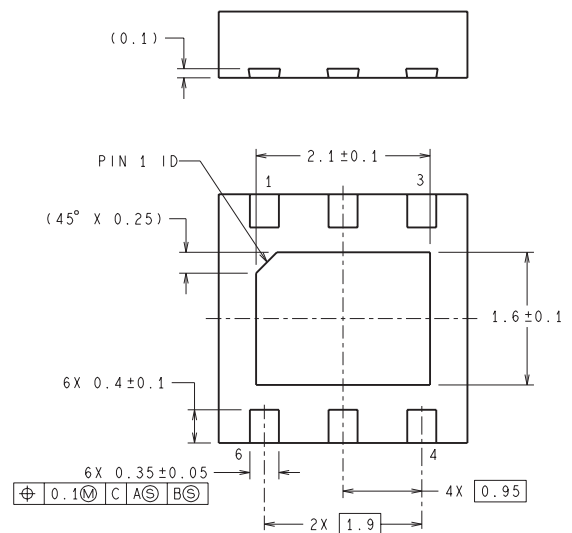
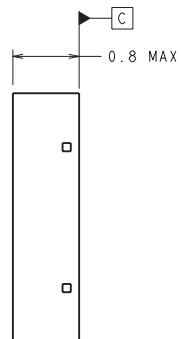
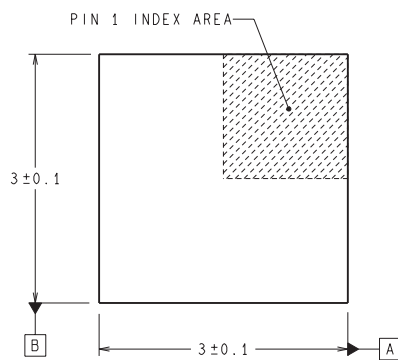
NOTES: (continued)

6. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
7. Board assembly site may have different recommendations for stencil design.



**DIMENSIONS ARE IN MILLIMETERS**  
DIMENSION IN ( ) FOR REFERENCE ONLY

## RECOMMENDED LAND PATTERN



SDE06A (Rev A)

## 重要声明和免责声明

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